

MESA+

INSTITUTE FOR NANOTECHNOLOGY

UNIVERSITY OF TWENTE.

Revolutionizing Silicon: The Synergy of Complex Oxides in Chip Technology

Complex oxide integration with Silicon

Guus Rijnders

*MESA+ Institute for Nanotechnology
University of Twente, The Netherlands*

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(Antwerp)



Jean Fompeyrine
(IBM, Lumiphase)



ect SIOX, Dutch NWO DESCO, ESTEEM



- Technical and social sciences
- 12000 students / 3000 staff
- 5 Faculties, 3 Research Institutes
 - Nanotechnology MESA+ (550 researchers/staf.)
 - TechMed Research Center
 - Digital innovation institute



University of Twente / MESA+ Institute for Nanotechnology





VISIT THE NANOLAB SITE

MESA+ INSTITUTE

REALISING **GRAND SOLUTIONS** WITH THE **EXTREMELY SMALL**

At MESA+, we believe in realising grand solutions with the extremely small. We contribute to solving current and future societal challenges. We do this by using our fascination with the extremely small. We bring societal challenges inside and use our fascination to work on innovative and sustainable solutions. We focus on societal challenges in four application areas: [Health](#), [AgriFood & Water](#), [Security](#), and [Energy & Sustainability](#).

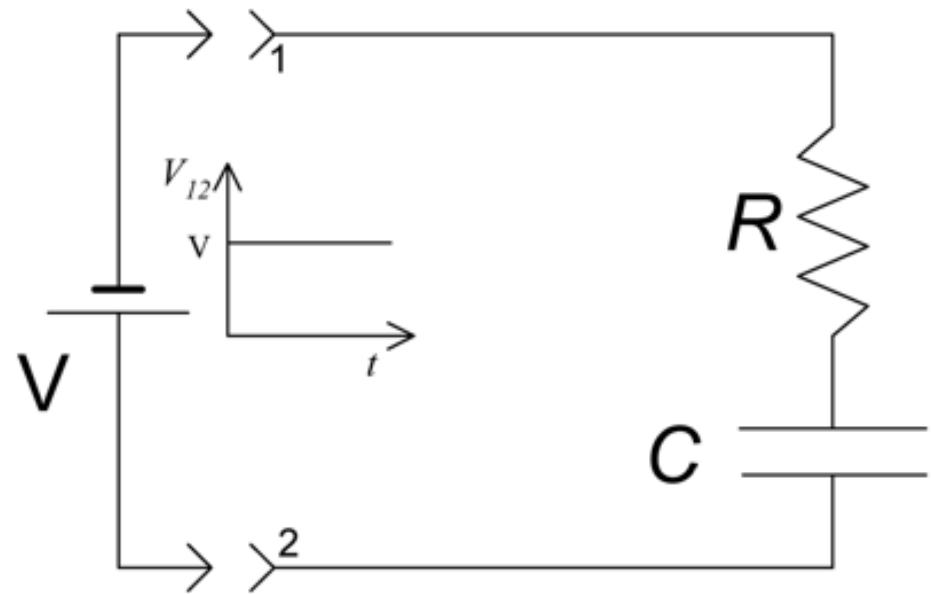
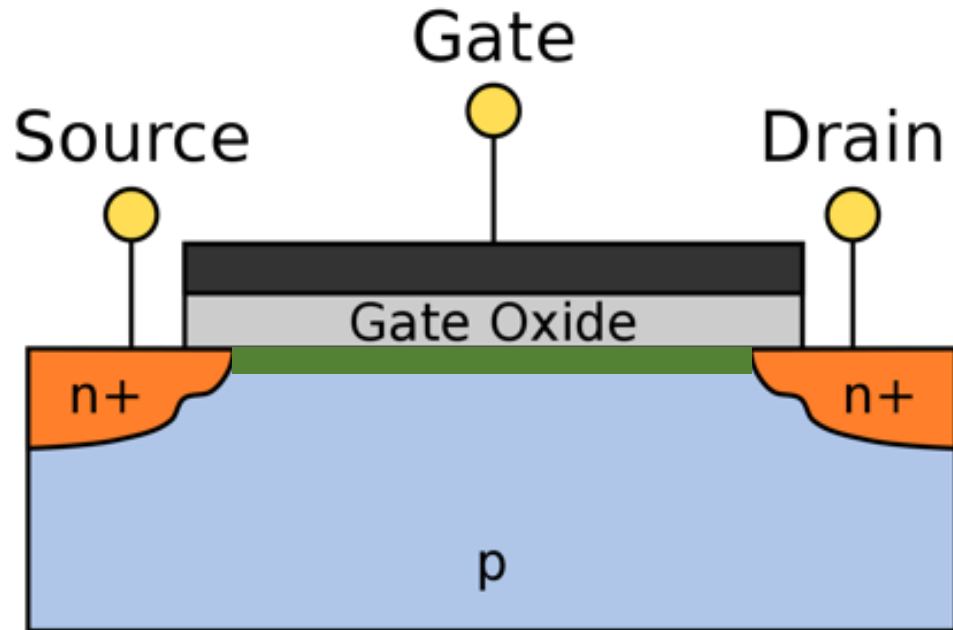
With our research, we contribute to a fair, sustainable and digital society.

An extremely small number:

0.000 000 000 000 000 000 01 (=10⁻¹⁷)

≈ energy cost per switch event for a modern transistor, in Joules
(= 0.000 000 01 nJ)

Transistor (MOS-FET)



$$E = \frac{1}{2} CV^2$$

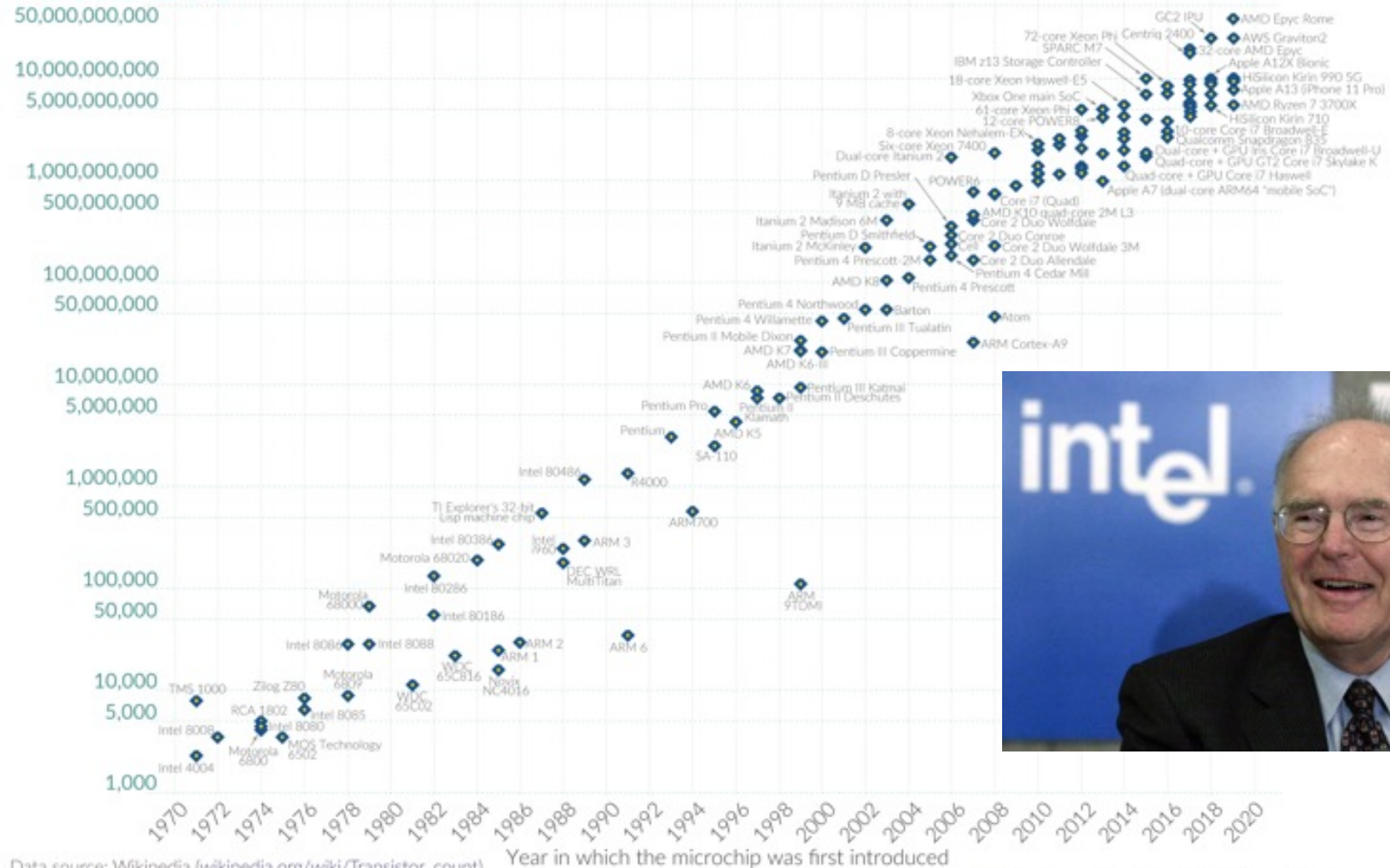
Characteristic charging time is RC

Moore's Law: The number of transistors on microchips doubles every two years



Moore's law describes the empirical regularity that the number of transistors on integrated circuits doubles approximately every two years. This advancement is important for other aspects of technological progress in computing – such as processing speed or the price of computers.

Transistor count

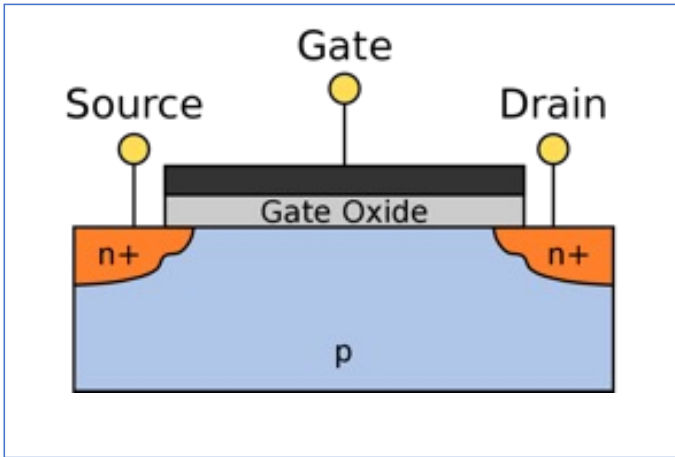


Data source: Wikipedia (wikipedia.org/wiki/Transistor_count)

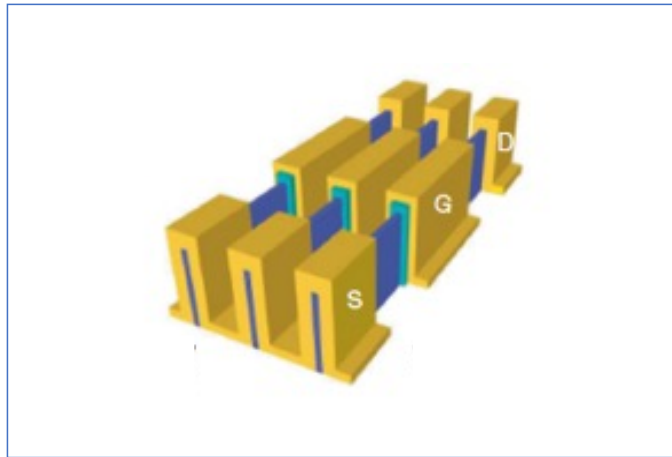
OurWorldinData.org – Research and data to make progress against the world's largest problems.

Licensed under CC-BY by the authors Hannah Ritchie and Max Roser.

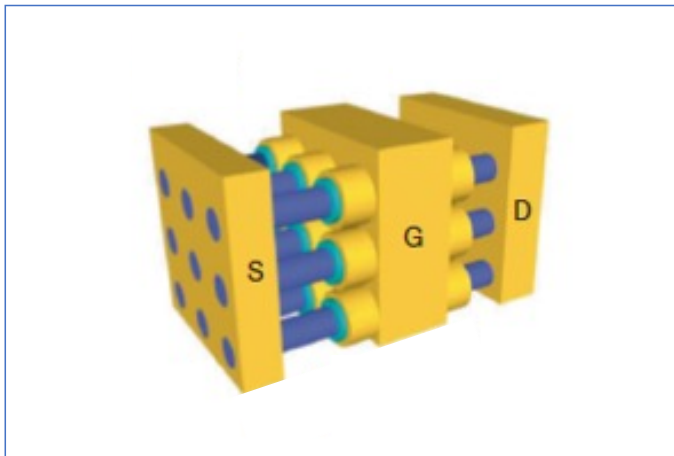




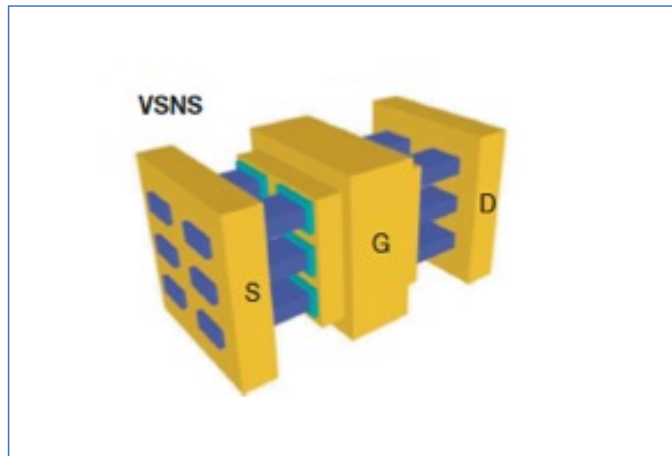
planar MOS-FET



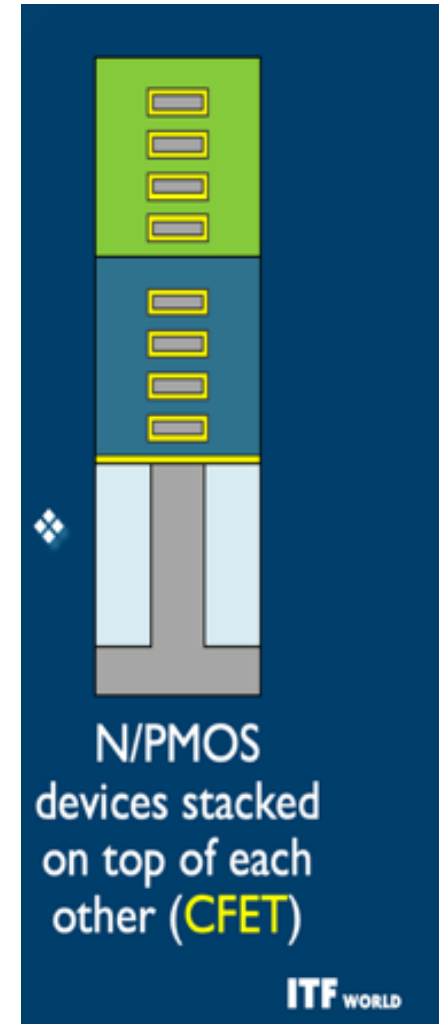
Fin-FET



Gate all around-FET

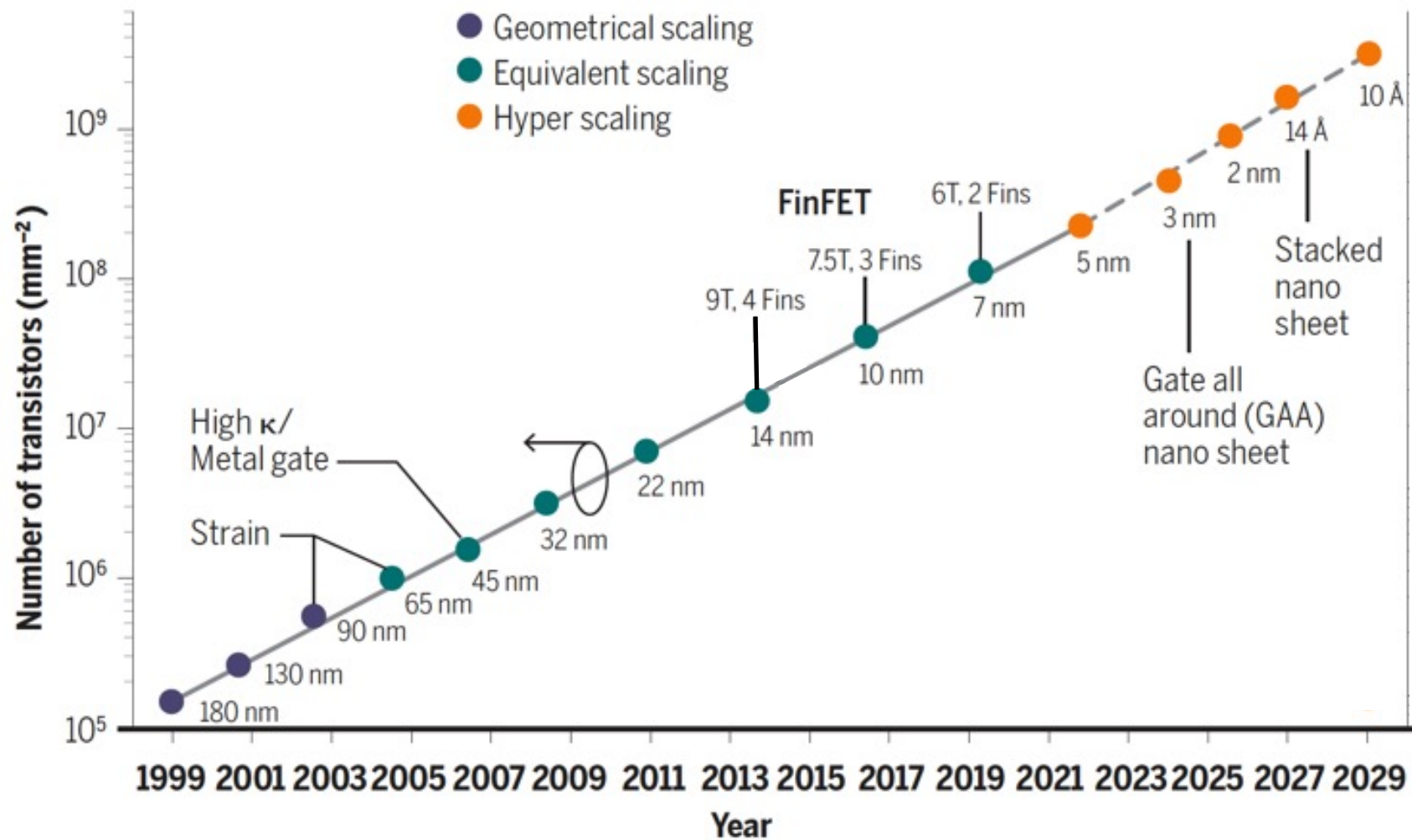


Vertically stacked nanosheets-FET

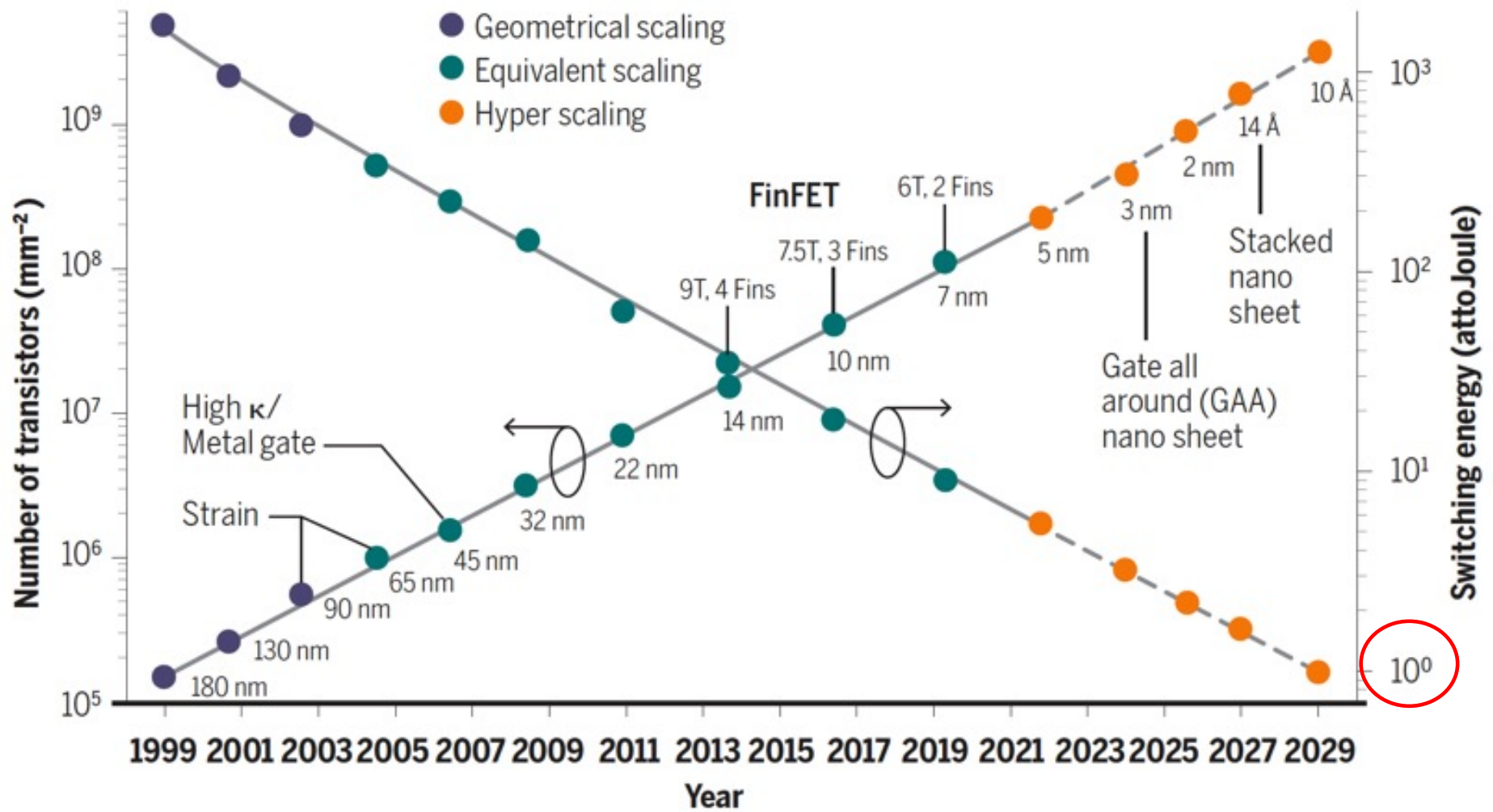


IMEC (ITF World Forum, 2023)

W. Cao *et al.*, *Nature* 620, 501 (2023)



Datta et al., Science 378, 733 (2022)



Datta *et al.*, *Science* 378, 733 (2022)

Opportunities for complex oxide research in the context of 'more Moore':

Concepts and materials for next generations CMOS:

2D materials (properties and synthesis), CMOS configurations (tunnel FETS etc), novel dielectrics, ferroelectrics, high-mobility / low scattering materials, low contact resistances, etc.

Materials transferring concepts (e.g., using nano-sheets)

Merging functions like sensing, imaging and information processing 'at the edge';

(a.k.a.: 'More than Moore')

Many possibilities for e.g.: CMOS-based chip design, ('chiplet'-)integration with photonics, biochemical devices, NEMS, local energy harvesting/storage devices, etc.

Thermal management (fluidics/gas/foams, thermal diodes, thermoelectrics)

Let's also look outside of the Moore box



An extremely big number:

1 000 000 000 000 000 000 000 000 000 000 000 000 000 000 000

= estimated number of transistor switch events per year worldwide (10^{36})

A big number times a small number can still be a big number ...

100 (10³⁶)

x

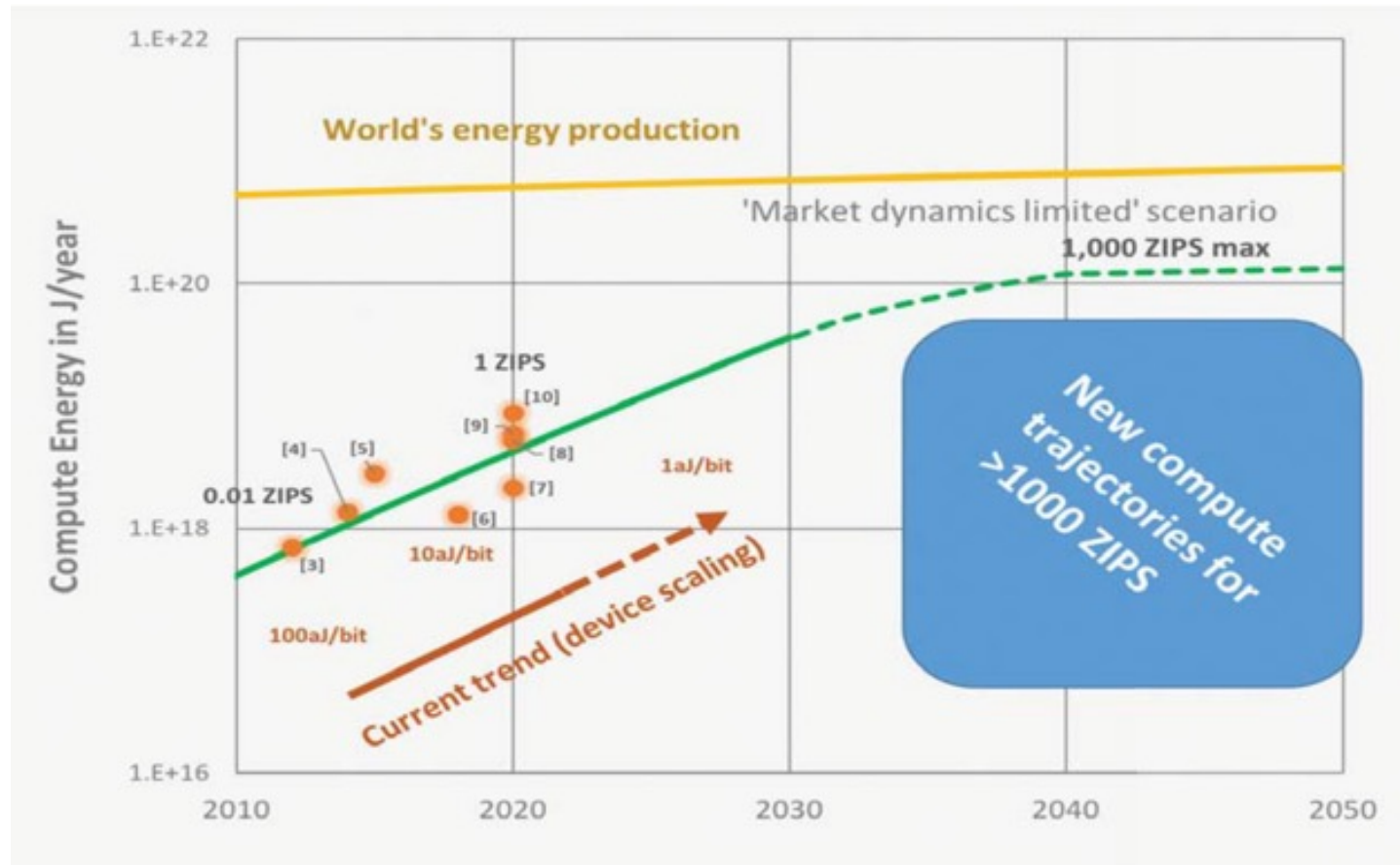
0.001 (10⁻¹⁷)

=

10 000 000 000 000 000 000 000 (10¹⁹)

≈ Energy consumption transistor switching worldwide per year in Joules

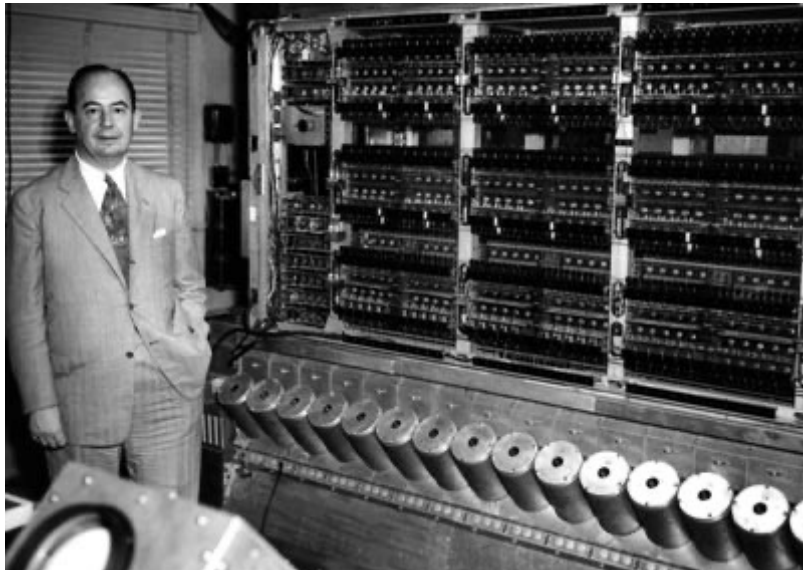
Problem: Energy consumption of computing is large and increasing



Currently: approx. 10^{36} transistor switches / year
Moving towards $> 10^{42}$ transistor switches / year in 2050

SIA/SRC Decadal Plan for Semiconductors (2021)

In addition: Von Neumann computing involves separation of processing and memory



Data-transport and read/write operations:

On chip (SRAM):

fJ/bit

Off chip nearby: DRAM/USB/Harddisk:

pJ/bit – nJ/bit

External (e.g. data centers)

nJ/bit – \square J/bit

John von Neumann
(1903 – 1957)

Why do we need new computing technologies?



1 training: 9,200 GPUs 2 weeks: 1,287MWh
enough for 120 households for 1 year
CO₂ emissions equal to 1300 cars in 1 year.

~ 250 TWh per year
4.5 billion searches per day, more than
1.4 million kilograms of CO₂ per day

Growth of energy use is not sustainable

1: Brown, T. et al. Language models are few-shot learners. Adv. Neural Inf. Process. Syst. 33,1877.

1.D. Patterson, et.al, The Carbon Footprint of Machine Learning Training Will Plateau, Then Shrink, arxiv (2022)

2.L.F.W. Anthony, et.al, "tracking and predicting the carbon footprint of training deep learning models", arxiv 03051 (2020).

3.N. Jones, "How to stop data centres from gobbling up the world's electricity. Nature, (12 September 2018).





NOS Nieuws • Woensdag 30 september 2020, 17:05



Opening grootste windpark van Nederland; meeste stroom naar datacenter Microsoft



Heleen Ekker
redacteur Klimaat en
Energie

In de Wieringermeer is het grootste windpark op land van Nederland geopend. Voor de eigenaar van het park, het bedrijf Vattenfall, betekent het een feestje, voor een aantal omwonenden een bittere pil. Zij voelen zich onvoldoende serieus genomen in hun bezwaren tegen het park.

Een van de dingen die ze stoort, is dat veel groene stroom naar een datacentrum van Microsoft gaat. De molens kunnen stroom opwekken voor 370.000 huishoudens, maar het grootste deel van de elektriciteit gaat naar dat datacentrum, in het nabijgelegen Middenmeer.

Analyse • 9 aug 12:19

Waterslurpende datacenters verergeren de gevolgen van hete zomers



Clara Hernandez Lizarraga, Olivia Solon

Wereldwijde watertekorten leiden tot conflicten tussen AI-bedrijven die steeds meer koelwater nodig hebben en de bewoners van gebieden waar die centers zijn gevestigd. De enorme rekenkracht nodig voor AI doet de vraag explosief stijgen.



De plek waar het nieuwe datacenter van Meta Platforms gebouwd moet worden op de droge vlakte even buiten Talevera de la Reina in Spanje. Geschat koelwaterverbruik: piekverbruik tot 195 liter per seconde, 665 miljoen liter water per jaar. Foto: Paul Hanna/Bloomberg

Urgent interest in alternative energy-efficient concepts
blending in with ongoing developments in CMOS according to Moore's law.

From 'Beyond Moore' to 'Besides Moore'

-> Role for academic research to explore new concepts

'Besides Moore', possible directions:

Approximate/probability computing

Heterogenous integration of electronics / photonics / spintronics / 'any-other-onics'
(combining the best of different domains, requires good interfaces)

Analog/digital combinations

Cryo-CMOS and other low temperature concepts

Quantum Computing

Neuromorphic computing

$$256 \times 11 = ?$$

$$256 \times 11 = 2816$$



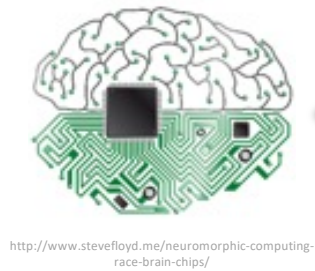


Application: Neuromorphic computing

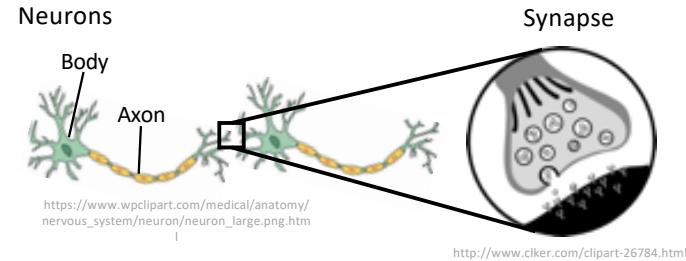
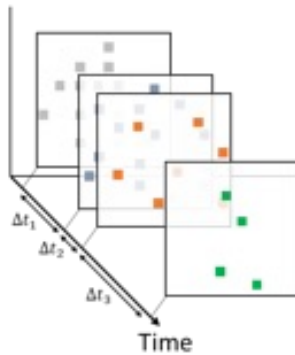
ULPEC

Synaptic plasticity

Brain-inspired processing unit



Dynamic vision sensor

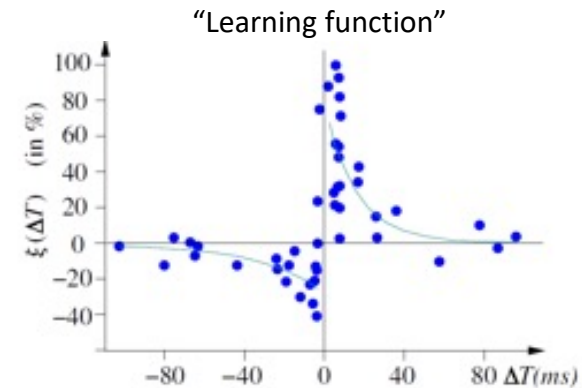


Spike time-dependent plasticity

$\Delta t = t_1 - t_2 > 0 \rightarrow$ synaptic strength is increased

$\Delta t = t_1 - t_2 < 0 \rightarrow$ synaptic strength is decreased

$\Delta t > \pm 80 \text{ ms} \rightarrow$ no change

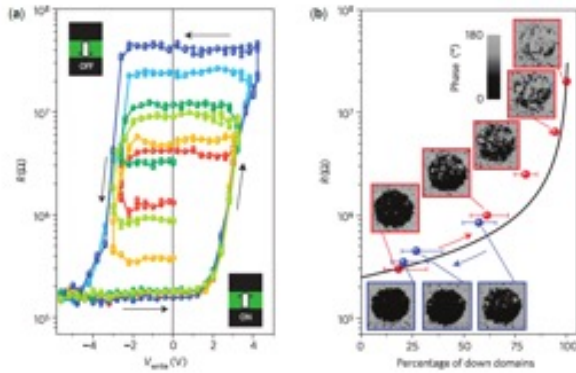


Saighi, S., *Frontiers in Neuroscience*, 9, 1–16.

Si-STO(4nm)//SrTiO₃(40nm) buffer

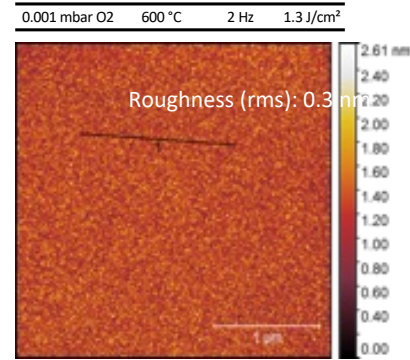
Memristive FTJs

Stack: NGO(001)//LSMO(30nm)/BTO(2nm)/Co(10nm)/Au(10nm)

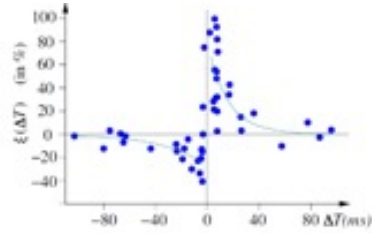
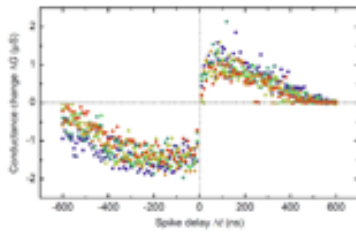


Chanthbouala, (2012). *Nat Mater*

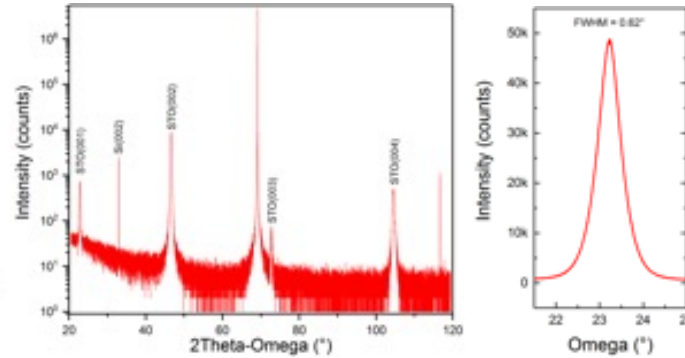
Heterostructure: SrRuO₃/2nm BaTiO₃



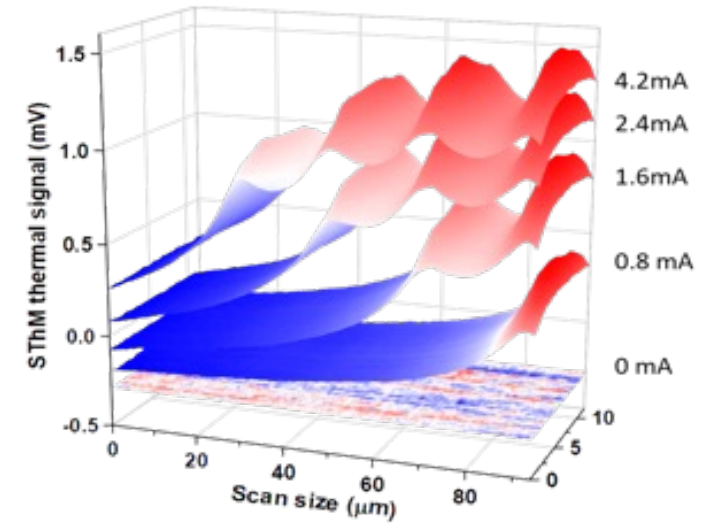
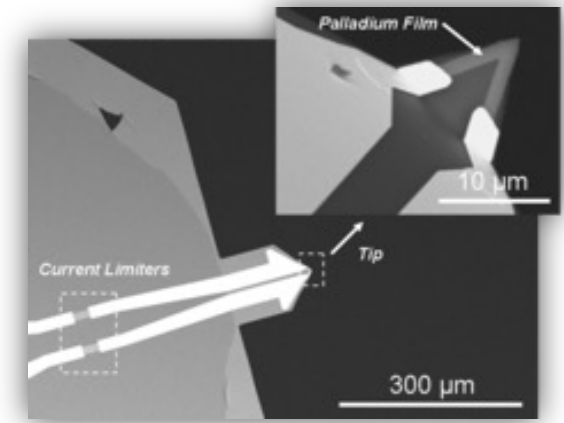
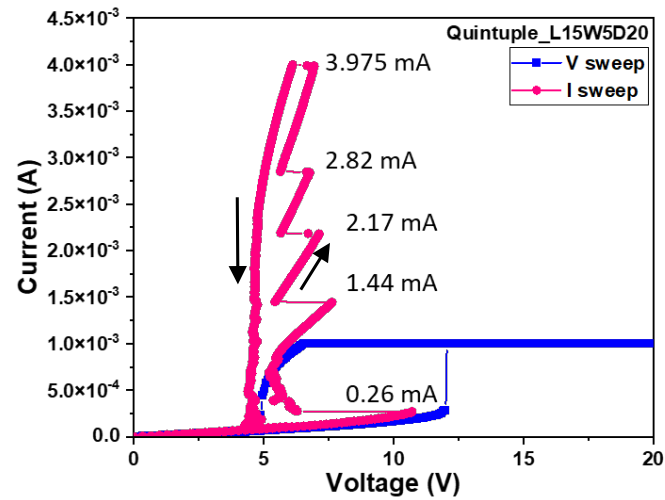
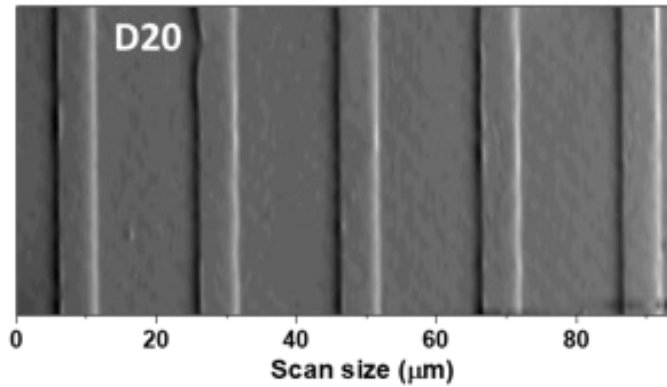
“Learning function”



Saighi, S., *Frontiers in Neuroscience*, 9, 1–16.



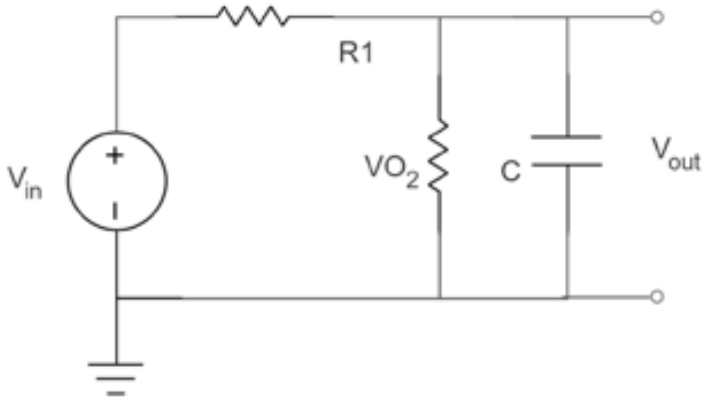
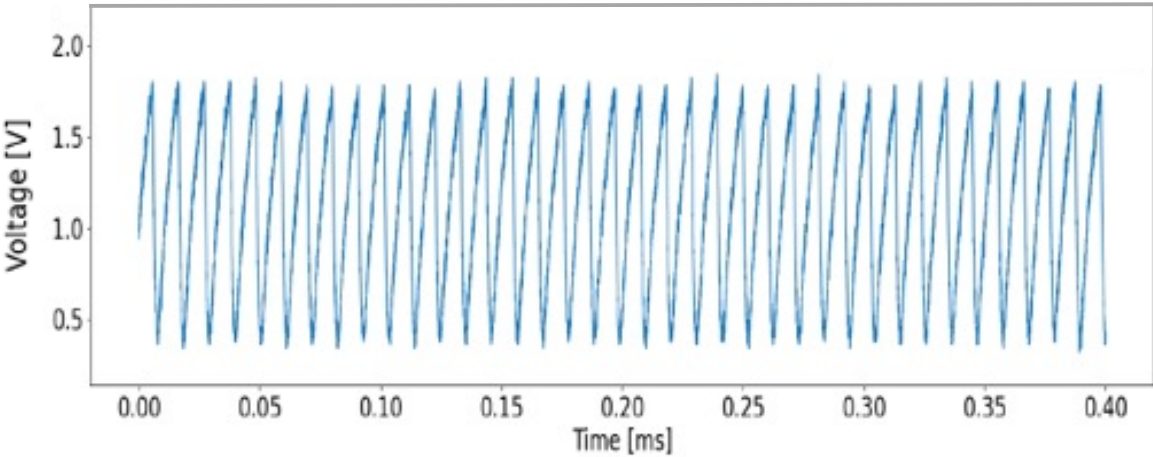
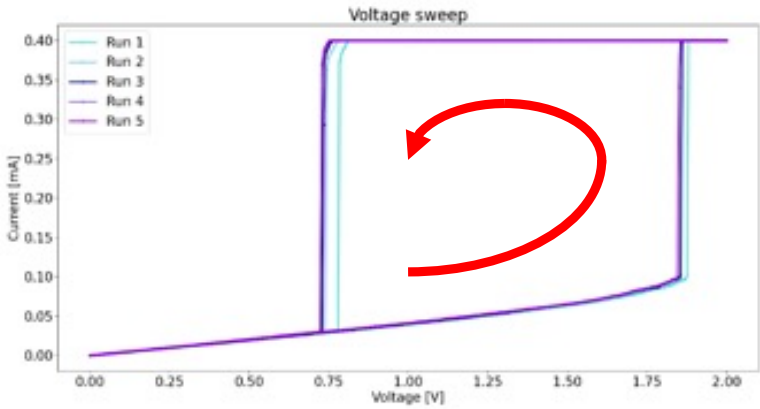
Multiple VO₂ bridges in parallel



X. Gao, T. Roskamp, T. Swoboda, C.M.M. Rosário,
S. Smink, M. Muñoz Rojo, H. Hilgenkamp, *Adv. Electr. Mater.* (Sept. 2023)

Scanning Thermal Microscopy

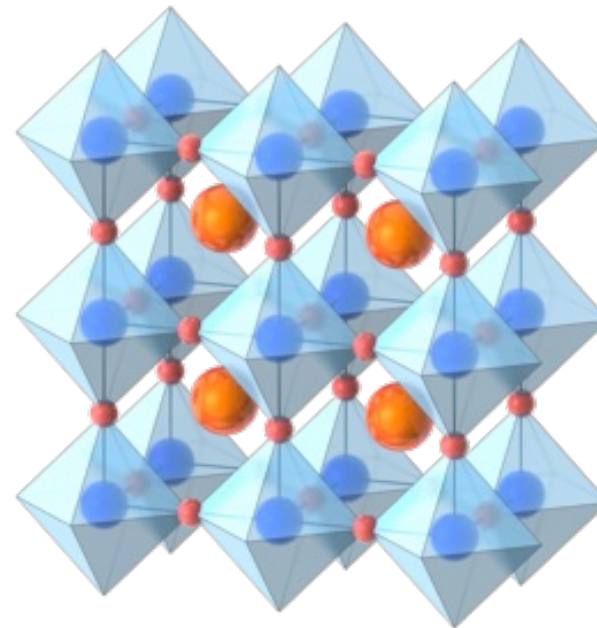
Artificial Neurons in VO₂



Renske van Poppelen,
Bachelor thesis (2023).

Transition metal oxides exhibit a wide range of functionalities due to the unique electronic and structural properties of transition metals. Here are some key functionalities :

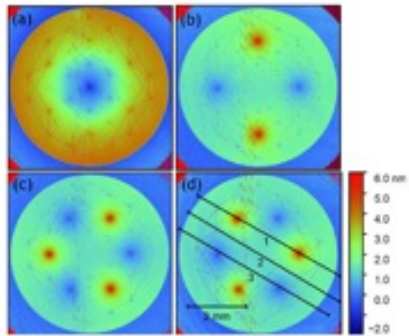
- 1.(Photo)-Catalysis**
- 2.Magnetic Properties**
- 3.Electrical Conductivity**
- 4.Superconductivity**
- 5.Optical Properties**
- 6.Ion Storage and Batteries**
- 7.Gas Sensing**
- 8.Ferroelectricity and Piezoelectricity**



ABO_3 perovskite

These functionalities arise from the diverse electronic configurations and bonding characteristics of transition metal oxides, making them versatile materials in various scientific and industrial fields.

Large area oxide thin film growth (100 mm and above) for Ferroelectric/Piezoelectric applications



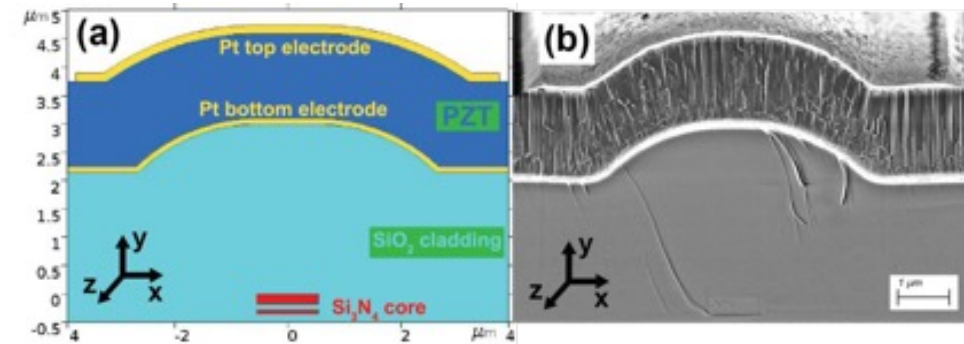
Adaptive optics for XUV lithography

Optics Letters Vol. 44, Issue 20, pp. 5104-5107 (2019)



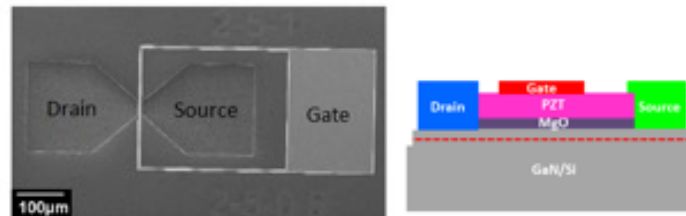
PiezoMEMS sensors and actuators

Adv. Energy Mater. 2022, 12, 2200517
 ACS Appl. Mater. Interfaces 2016, 8, 45, 31120–31127
 J. Phys.: Conf. Ser. 922 012022



Ultra-low power stress based phase actuation in SiN (quantum) photonic circuits

doi: 10.1117/12.2609405

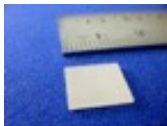


High Power GaN field effect transistors

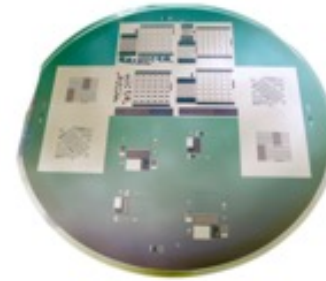
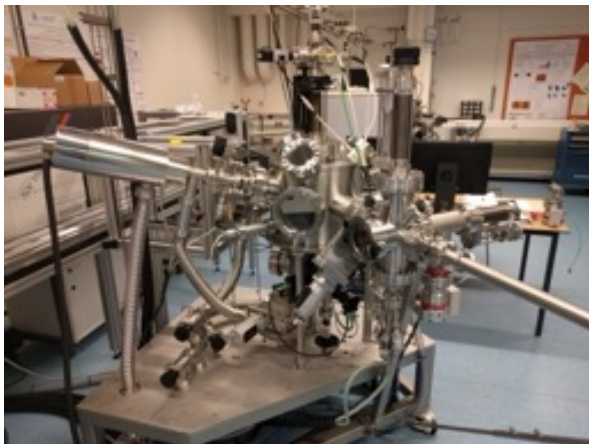
Journal of Crystal Growth, 538, 15 May 2020, 125620

- Large area deposition; PLD, sputter deposition, MBE, ...
- Epitaxial growth on non oxide/crystalline substrates; Si, Glass, ...
- How to deal with inhomogeneous deposition; growth rate, composition

Pulsed Laser Deposition: From Lab-scale to Industrial-scale

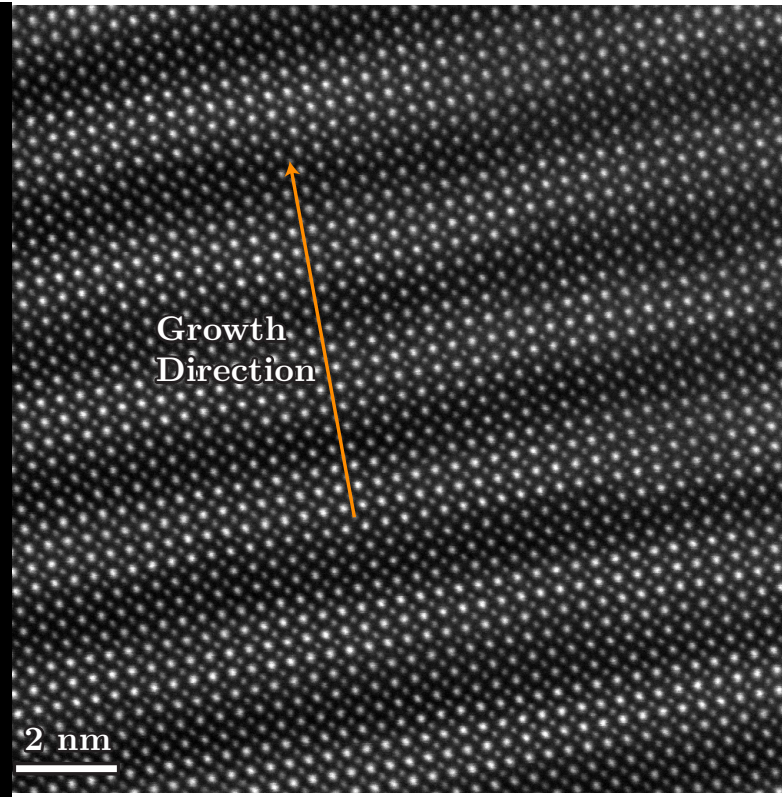
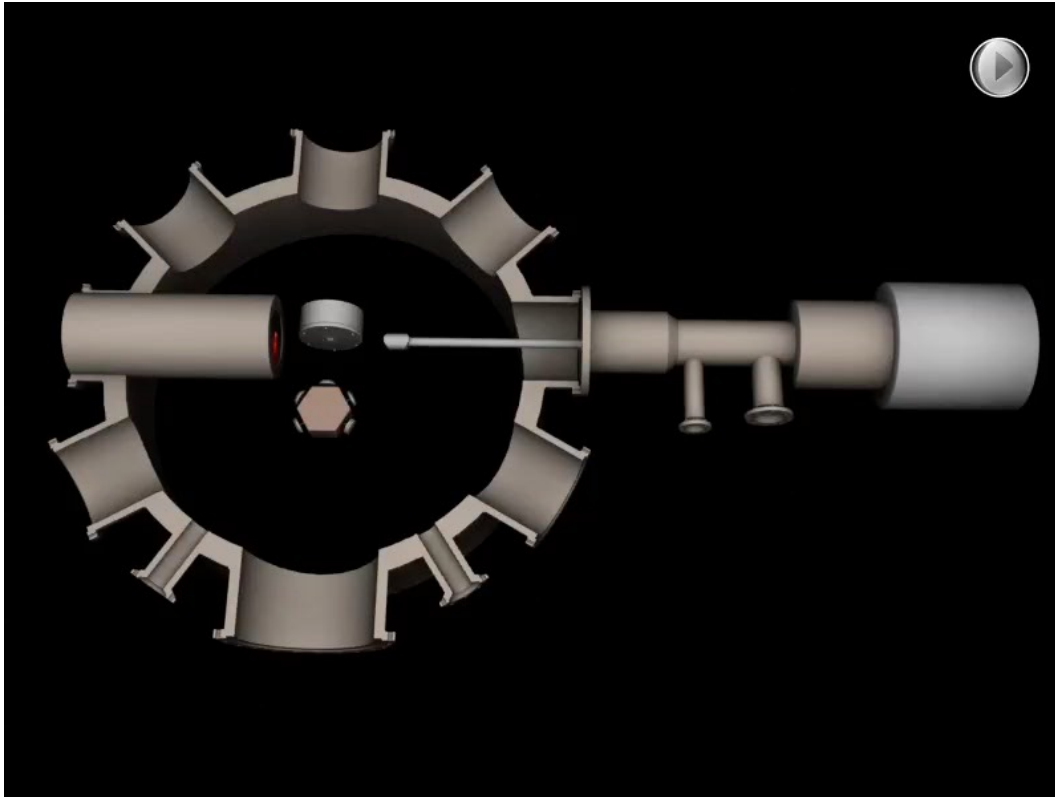


Up to 100 mm



Up to 300 mm

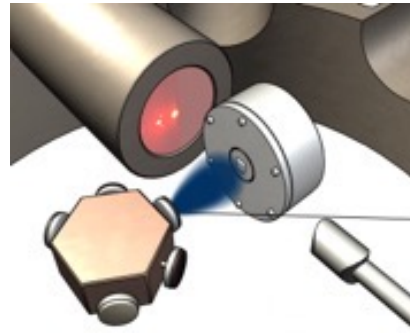




Atomic controlled epitaxial growth by PLD

Lessons learned

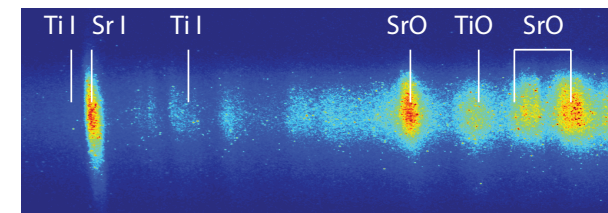
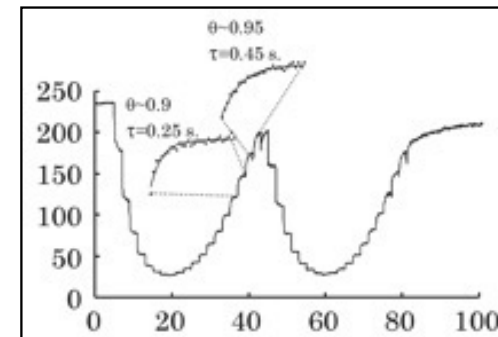
Single termination of perovskite substrates



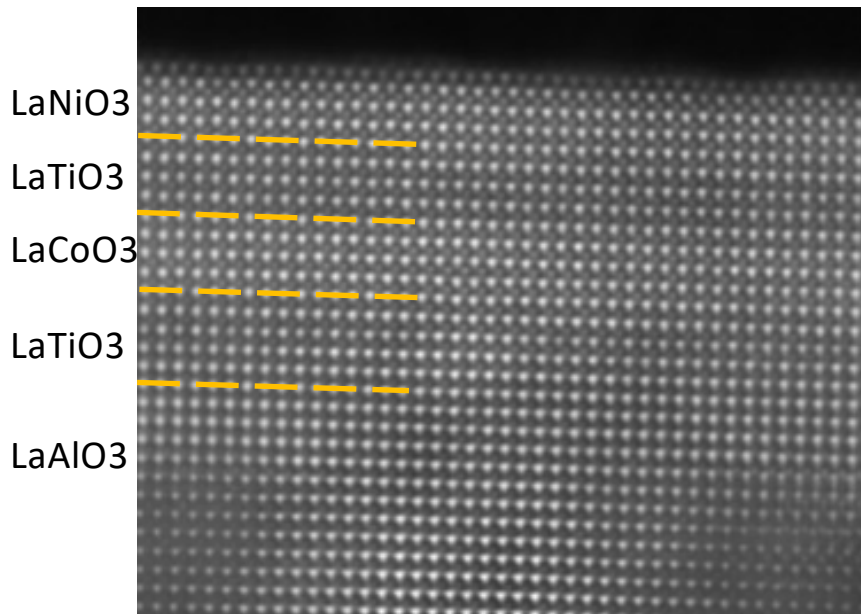
In-situ growth control

Understanding growth mechanism, nucleation and growth

Understanding role of chemistry/physics of deposited particles



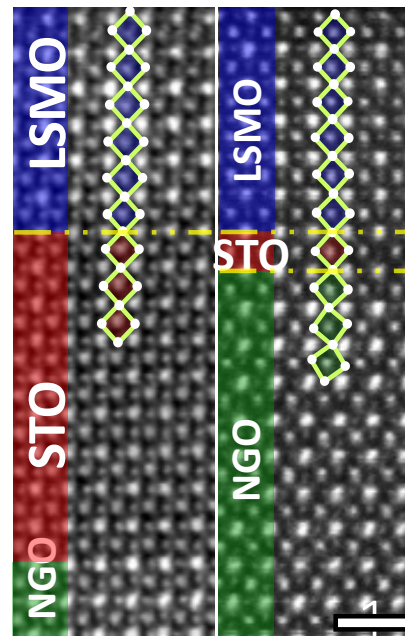
Epitaxial heterostructures



Charge transfer at interface of
LaCoO₃-LaTiO₃

J. Geessinck, GR, et al,

<https://doi.org/10.1103/PhysRevMaterials.4.026001>

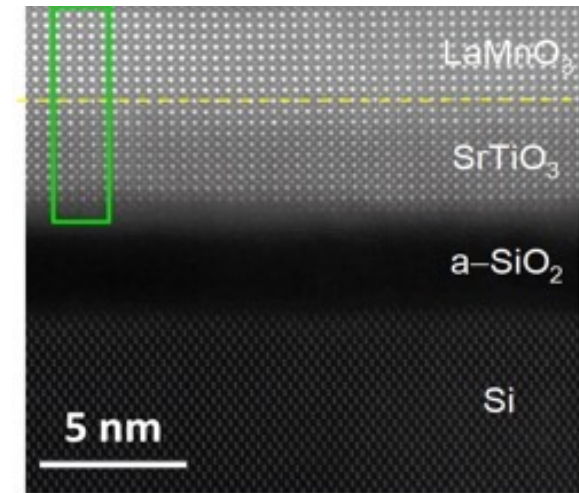


Symmetry transfer

Manipulate magnetic anisotropy

In (La,Sr)MnO₃

Z. Liao, GR, et al, Nature Materials volume 15, pages 425–431 (2016)

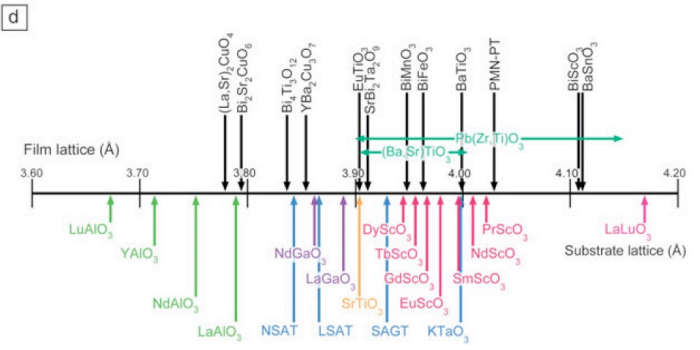
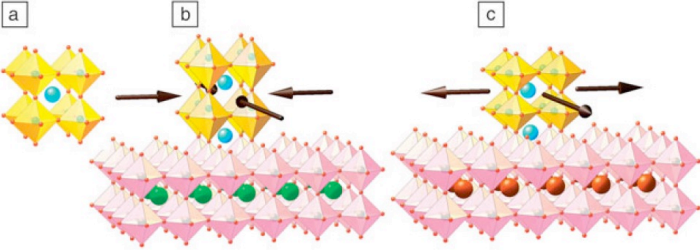


Complex oxide epitaxy on
Silicon.

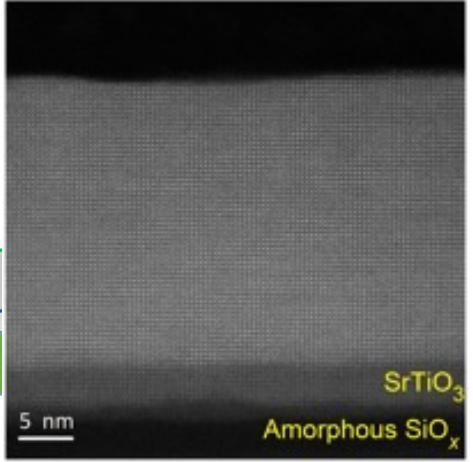
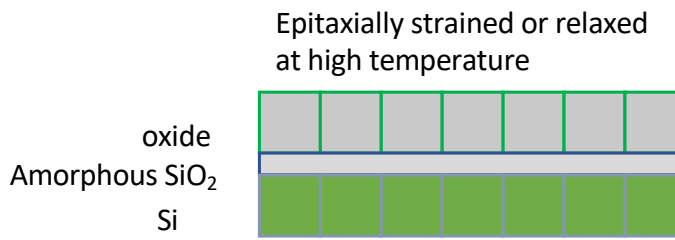
Darrell Schlom, Cornell

Jean Fompeyrine, IBM, Lumiphase

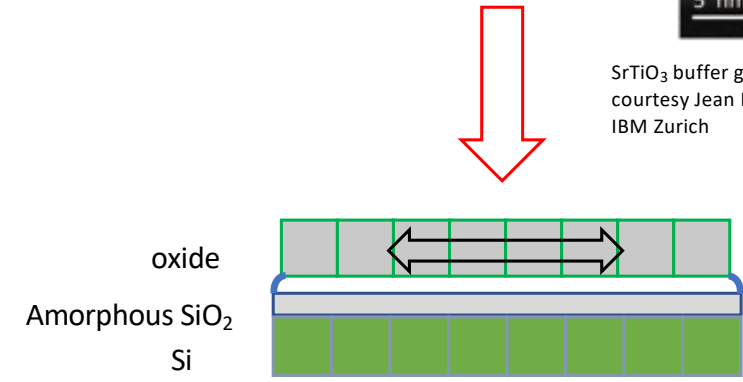
Prominent features of oxide-Si integration: buffer layer and thermal tensile strain



Epitaxial strain induced by lattice mismatch



SrTiO₃ buffer grown by MBE, courtesy Jean Fompeyrine, IBM Zurich

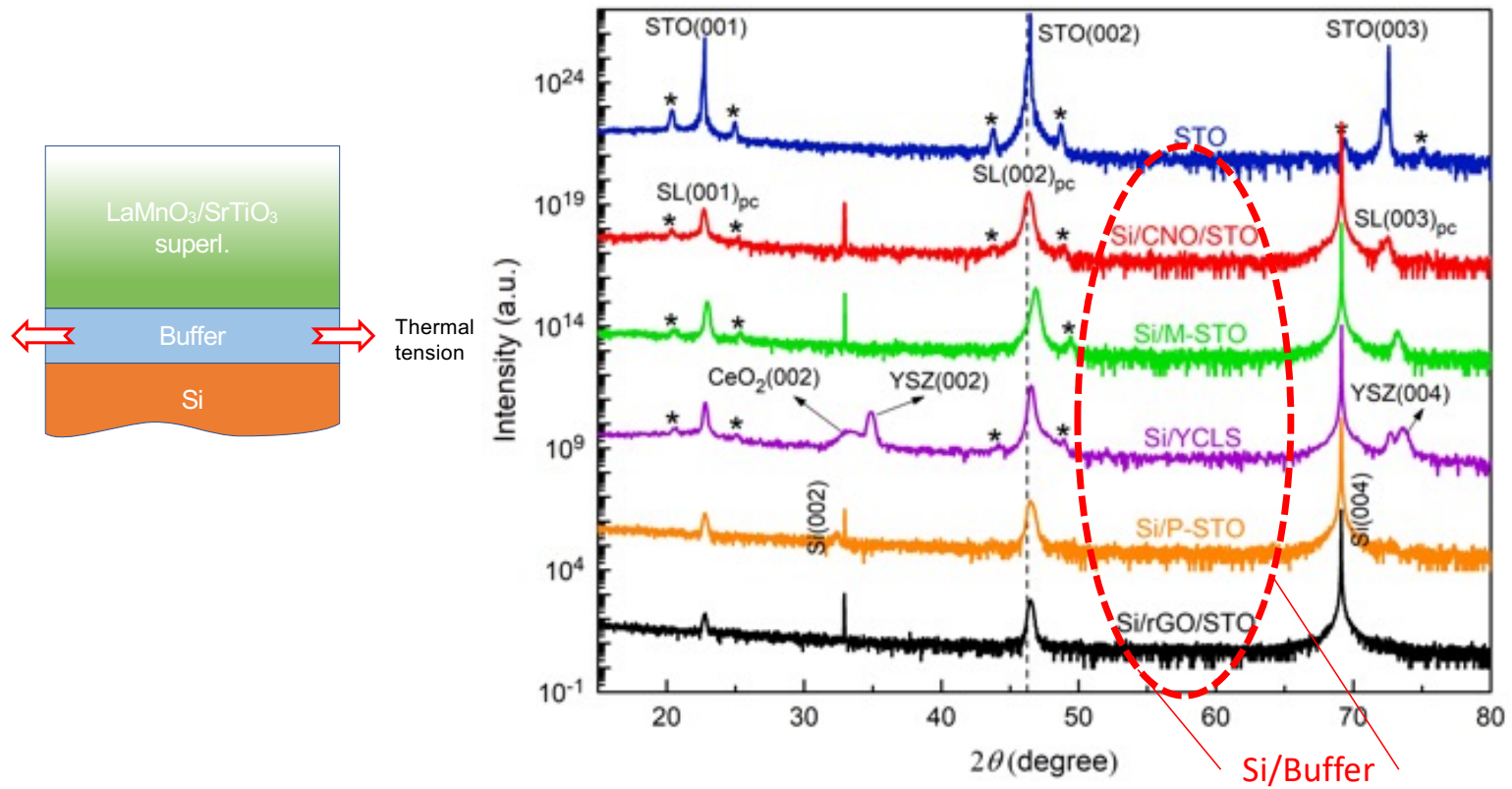


Tensile strained after cooling down

Thermal expansion coefficient α : $\alpha_{oxide} \gg \alpha_{Si}$

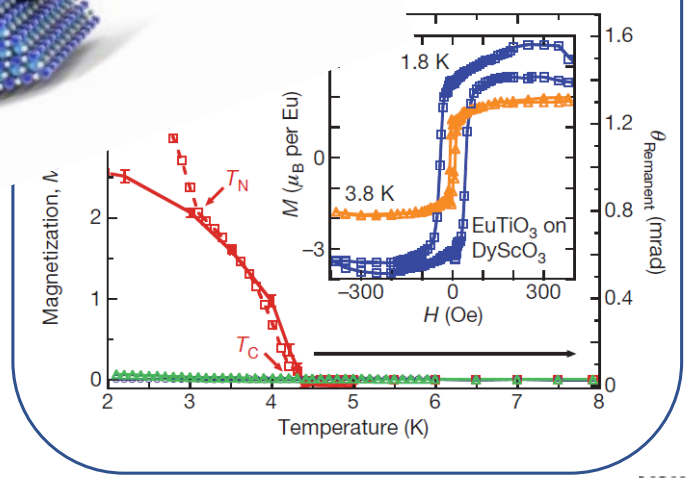
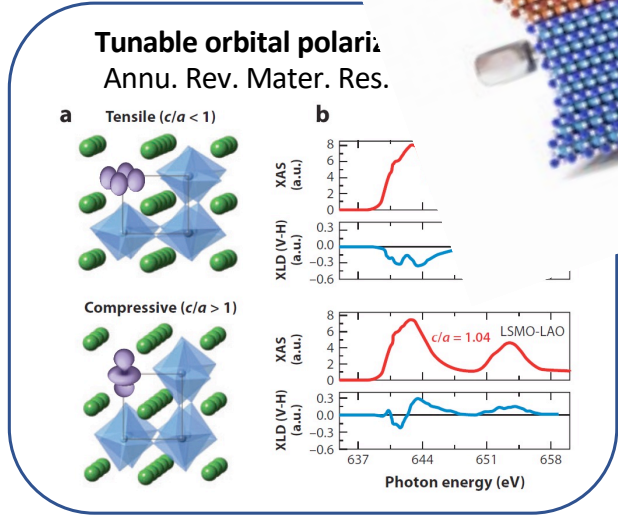
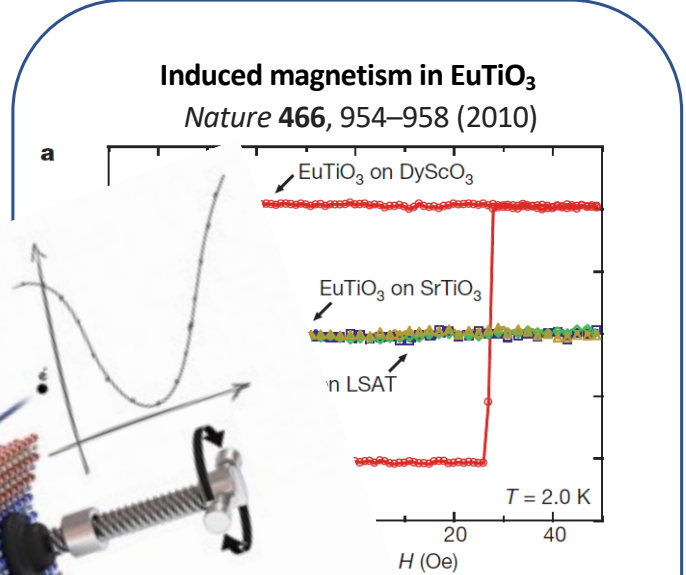
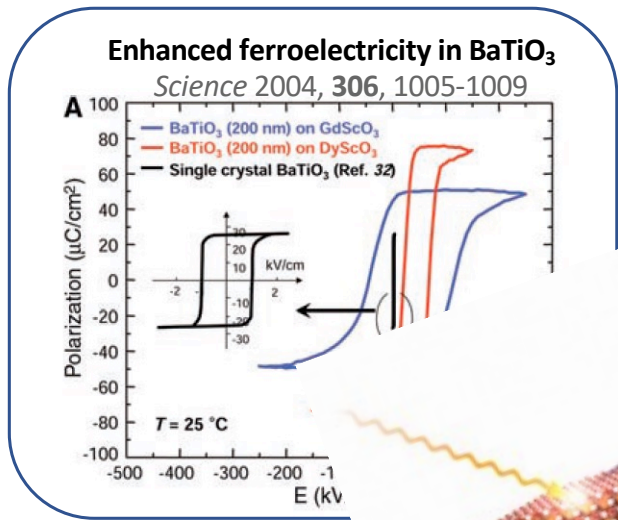
Thermal strain scales with the temperature difference between growth and final operating temperature.

Integrating LaMnO₃/SrTiO₃ superlattices on silicon using various template techniques:

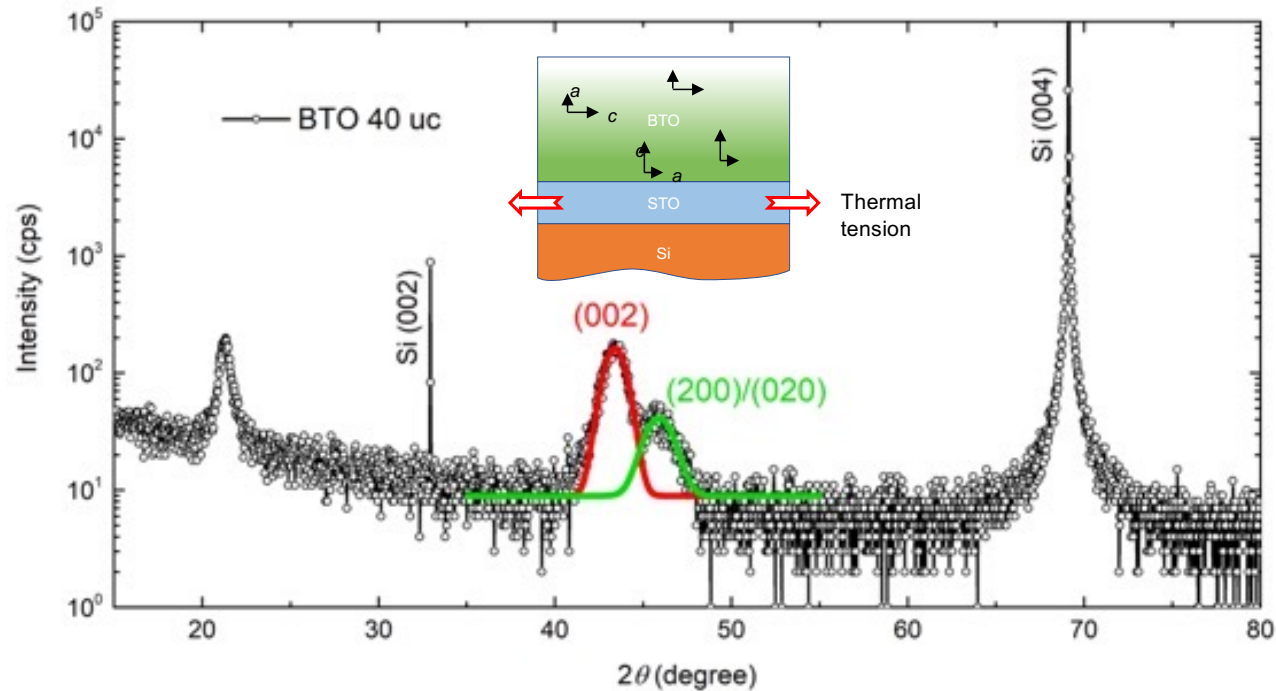


Chen, GR et al, ACS Appl. Mat.&Int.

Strain and oxide functionalities: charge, spin, orbital

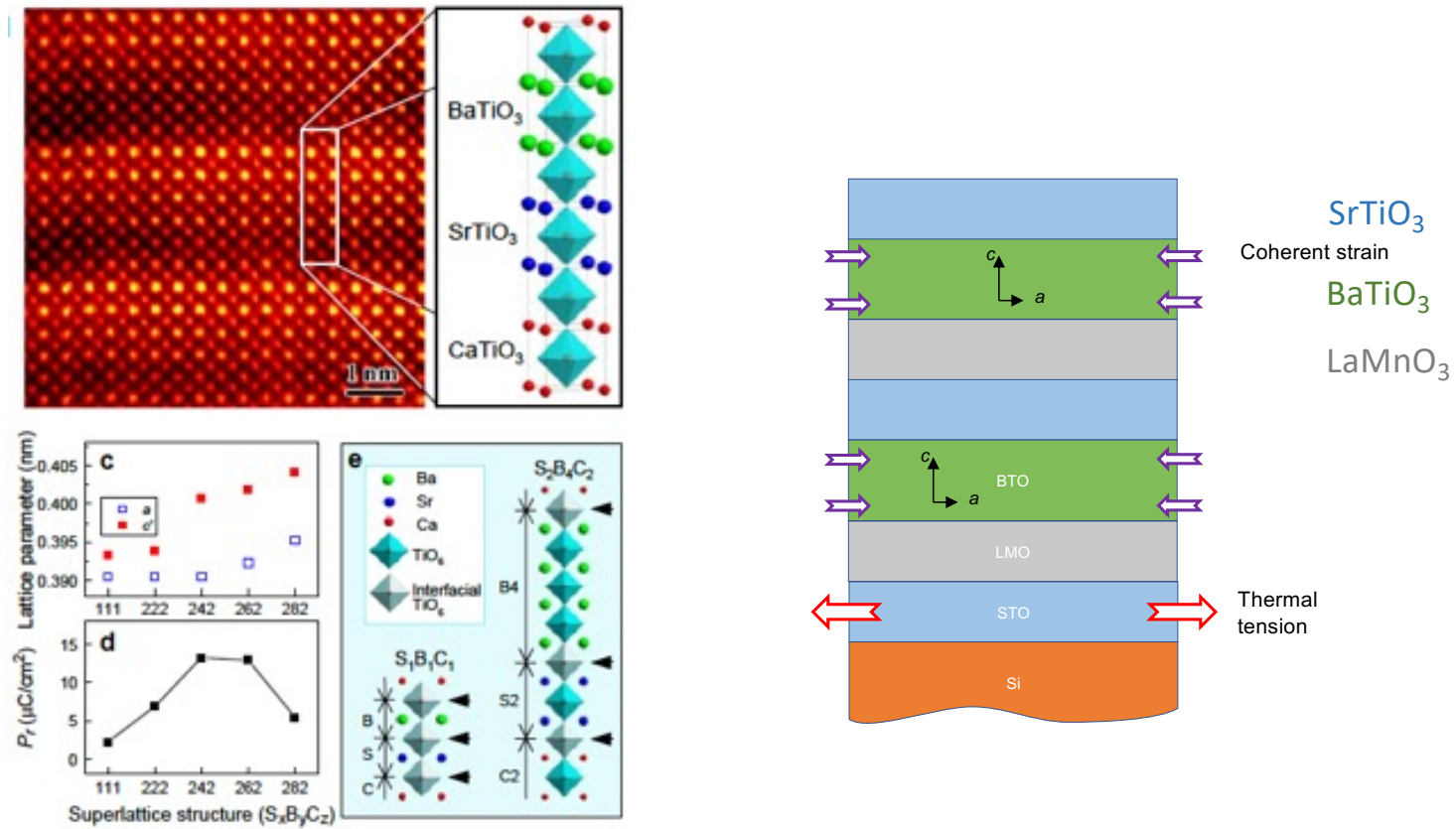


Multi-domain states in BaTiO₃ single films grown on Si/SrTiO₃:



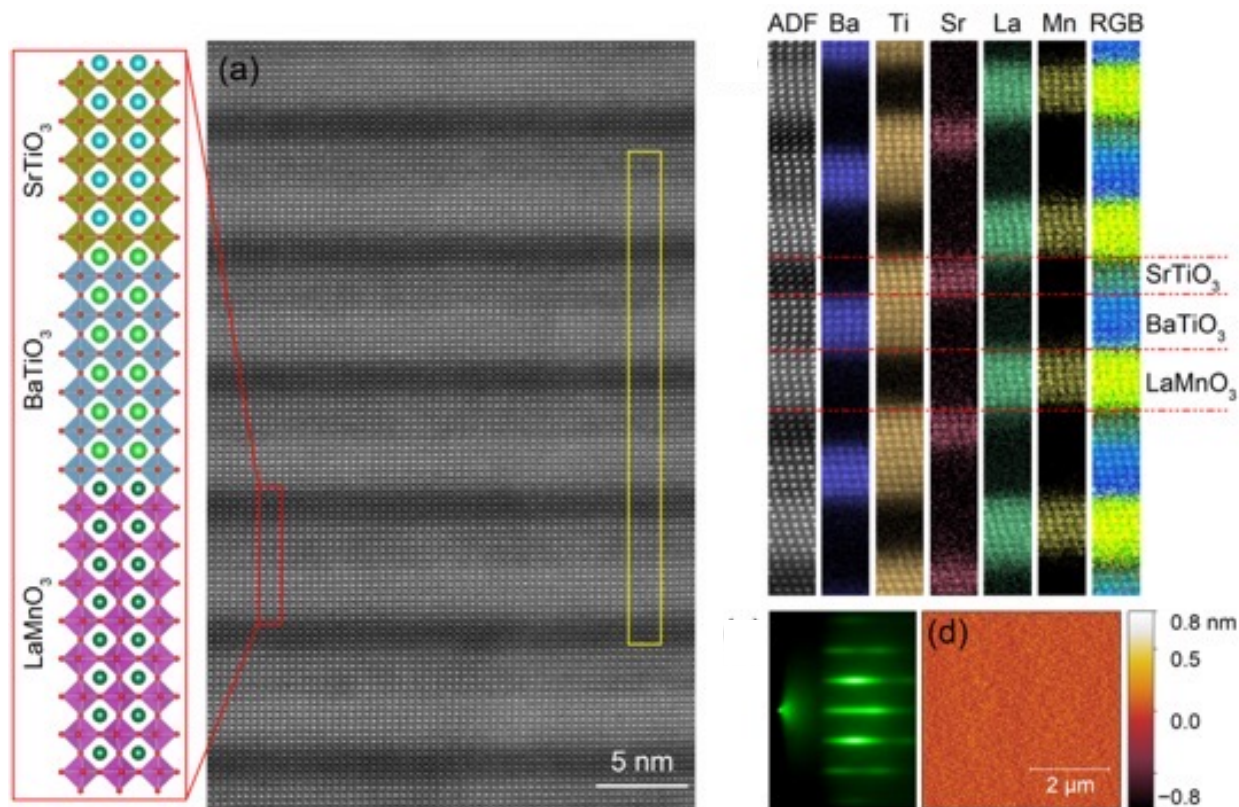
X-ray diffraction of a 40-uc thick BTO film grown on Si/STO. The double-peak feature clearly shows the coexistence of *a*- and *c*- domains, consistent with previous reports (Nature Nanotechnology **8**, 748 (2013); Nature Communications **4**, 1671 (2013); Nanotechnology **24**, 285701 (2013)).

BaTiO₃ in three component ferroelectric superlattices



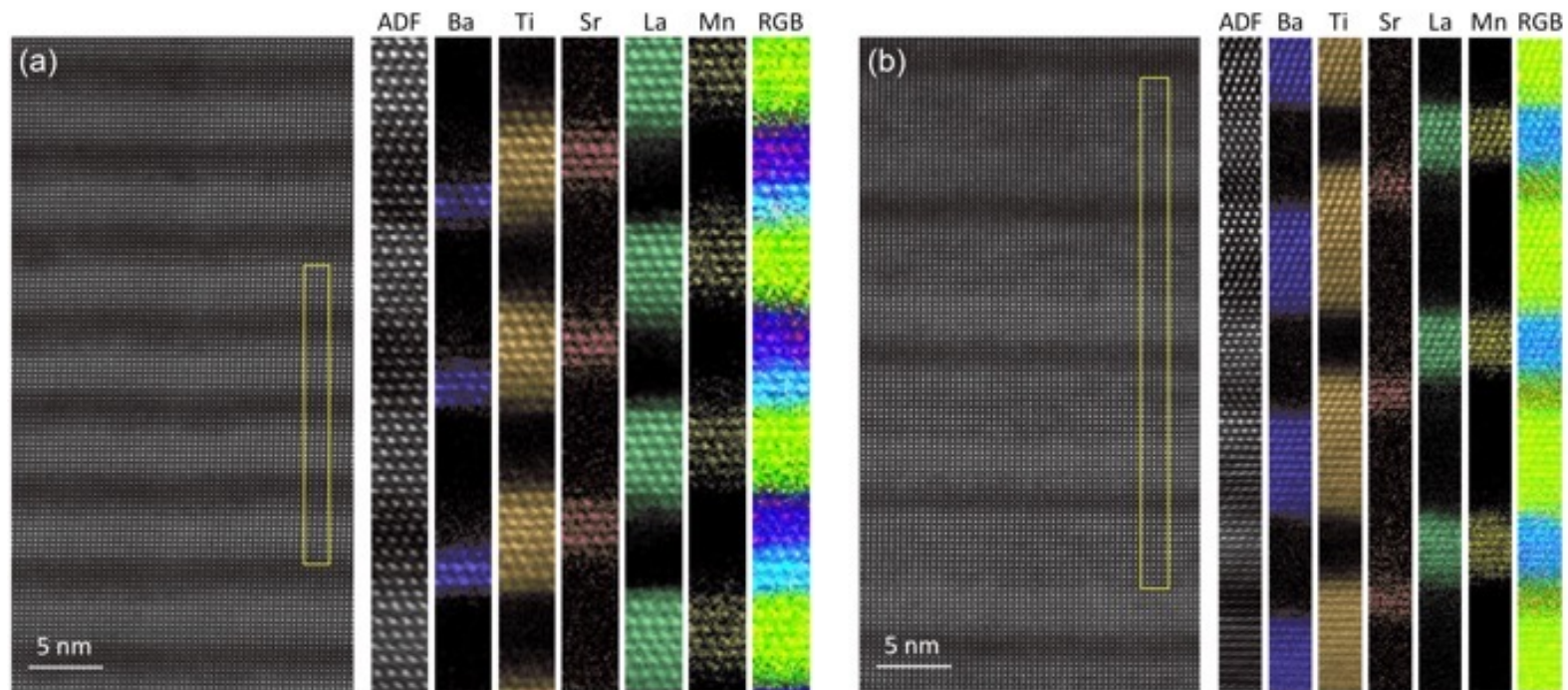
Strong polarization enhancement in asymmetric three component ferroelectric superlattices
 Ho Nyung Lee, Nature 433, 395-399 (2005)

Structural characterization

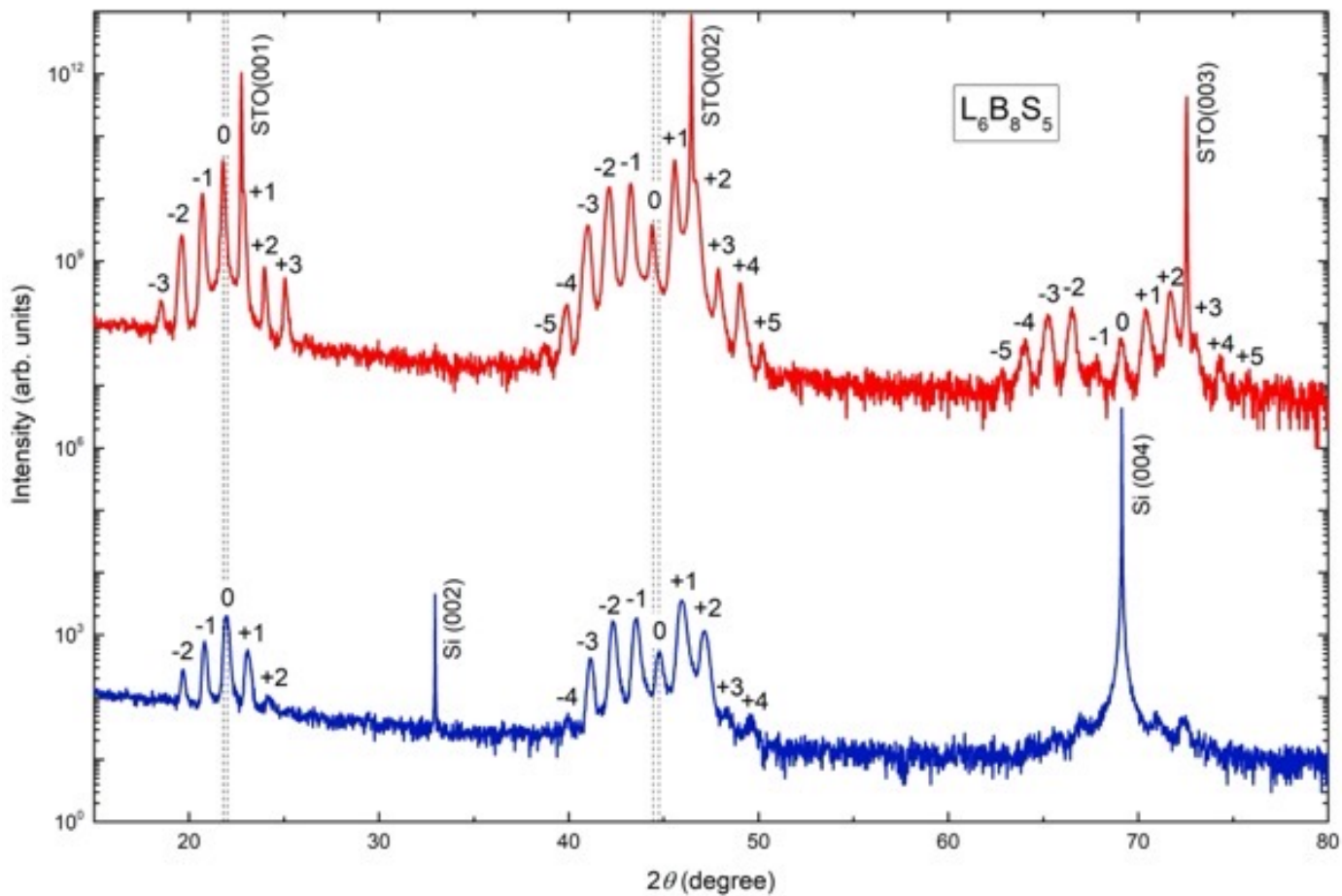


STEM-EELS measurements
courtesy Nicolas Gauquelin,
UAntwerpen

(a) STEM image of $L_8B_6S_5$ superlattice grown on Si/STO. The sketch on the left shows the atomic structure in one period. The EELS elemental maps taken from the yellow rectangular area are shown in (b). (c) and (d) show the RHEED image taken along the Si[110] azimuth and AFM image.

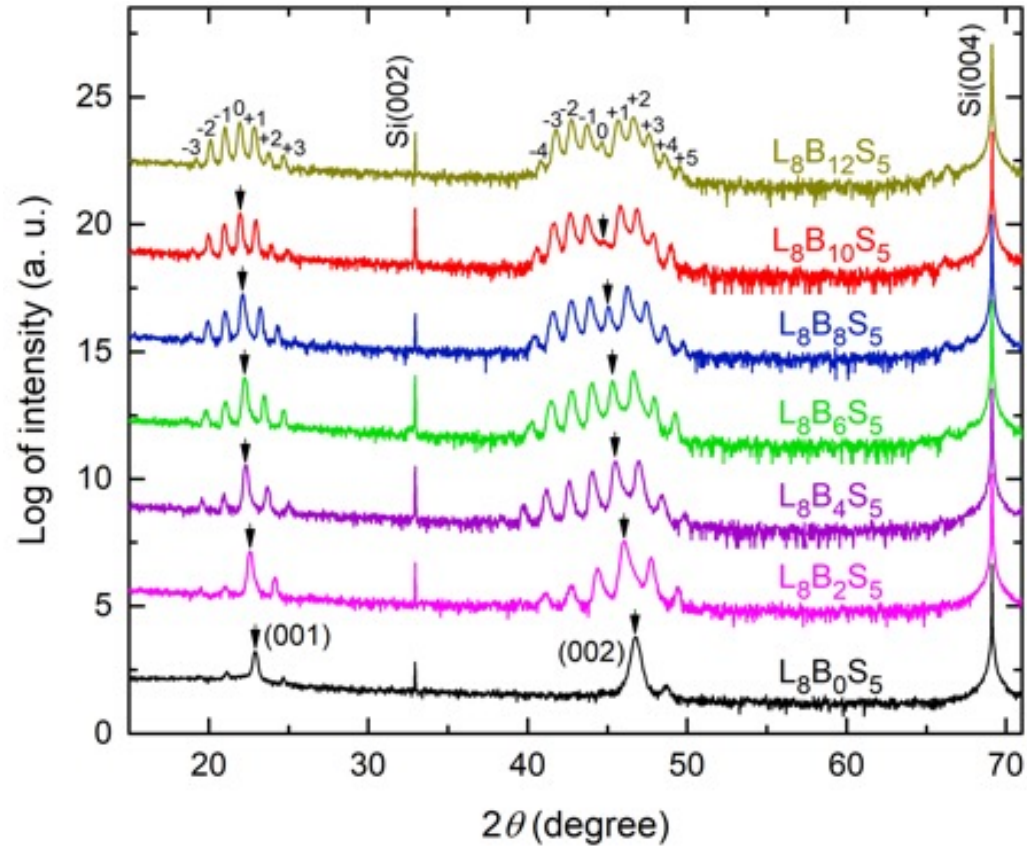


STEM images and EELS elemental maps of $L_8B_2S_5$ (a) and $L_8B_{12}S_5$ (b) superlattice grown on Si/STO.



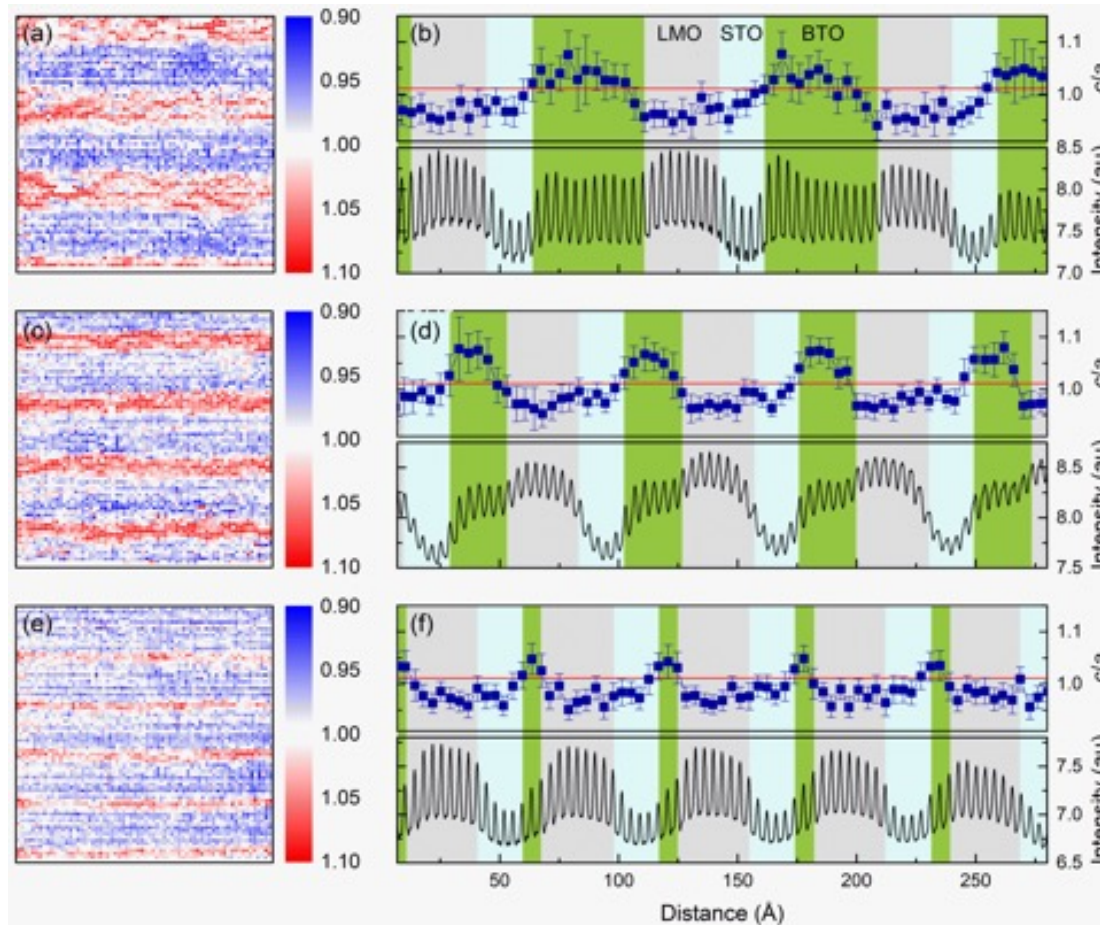
XRD θ - 2θ scans of two $L_6B_8S_5$ SLs grown on STO single crystal (red) and Si/STO (blue) substrates. The main peaks, as indicated by dotted lines, shift to higher angles for the SL grown on Si/STO because of the in-plane thermal tension.

LaMnO₃/BaTiO₃/SrTiO₃ superlattices with varied BTO thickness:



XRD linear scans of LMO/BTO/STO superlattices with various layer thickness of BTO grown on Si/STO. The arrows indicate the (001) and (002) main peaks.

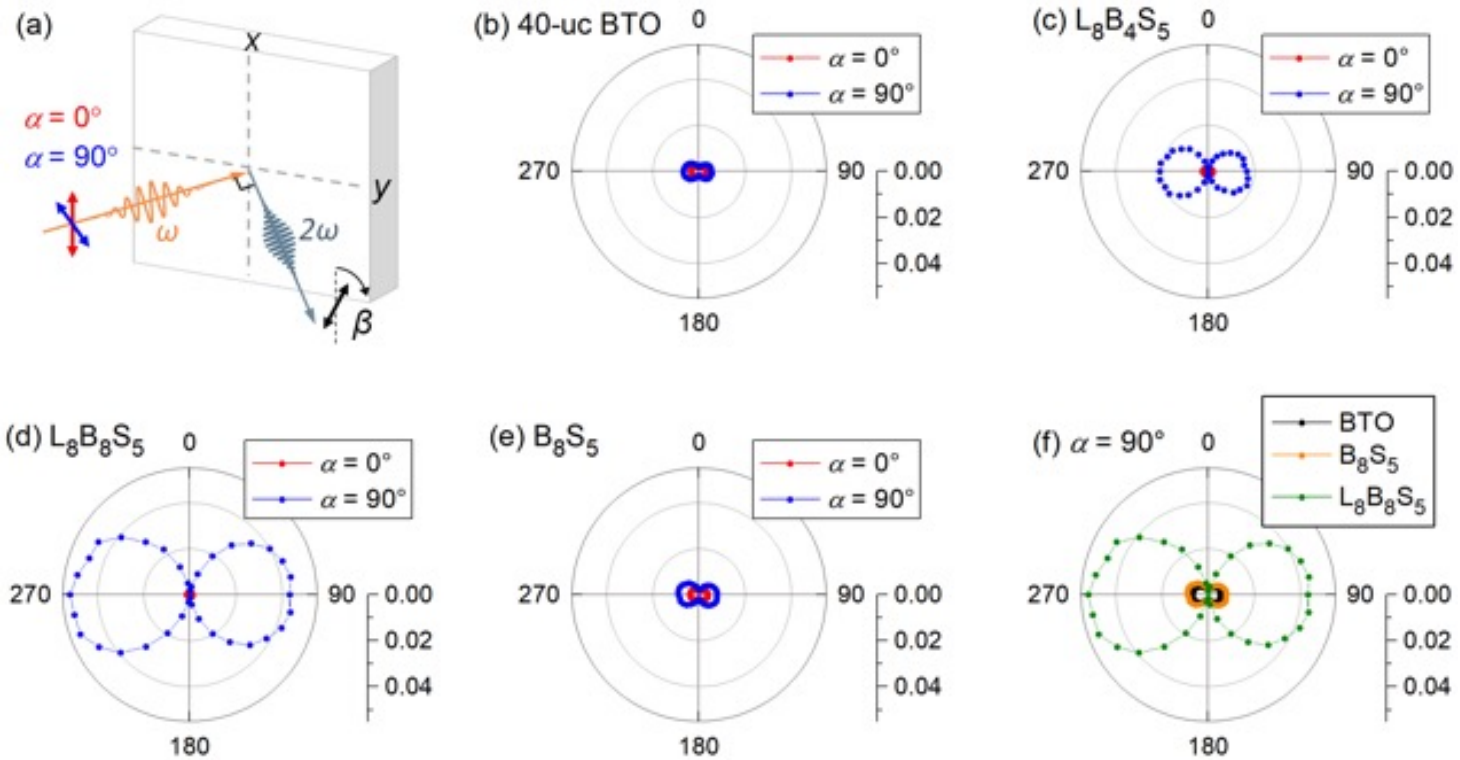
Mapping tetragonal distortions:



For comparison:
Bulk BTO : $c/a = 1.01$
PbTiO₃ : $c/a = 1.06$

Two-dimensional mapping of tetragonality (c/a) for L₈B₁₂S₅ (a), L₈B₆S₅ (c) and L₈B₂S₅ (e). The corresponding c/a averaged within each atomic layer is plotted in (b), (d) and (f), respectively. In (b), (d) and (f), the red line in upper panels indicates the c/a value of BTO single crystal, and the bottom panels show the HAADF intensity for identifying each layers.

polarization

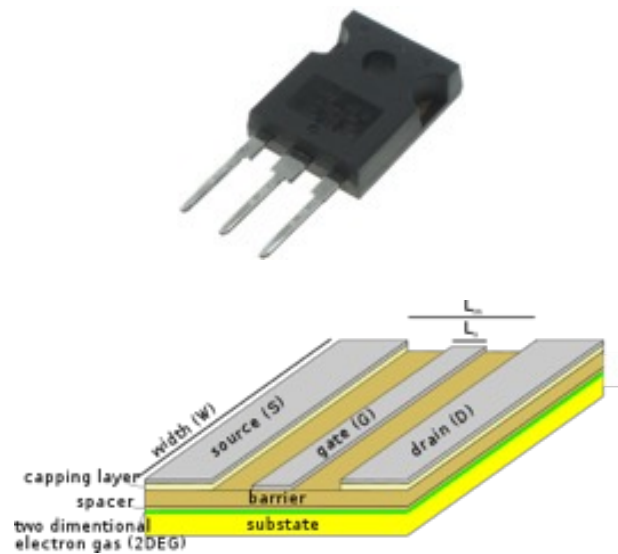


SHG measurements done in collaboration with Nives Strkalj, Martin Sarott, Manfred Fiebig, Morgan Trassin, (ETH Zurich)

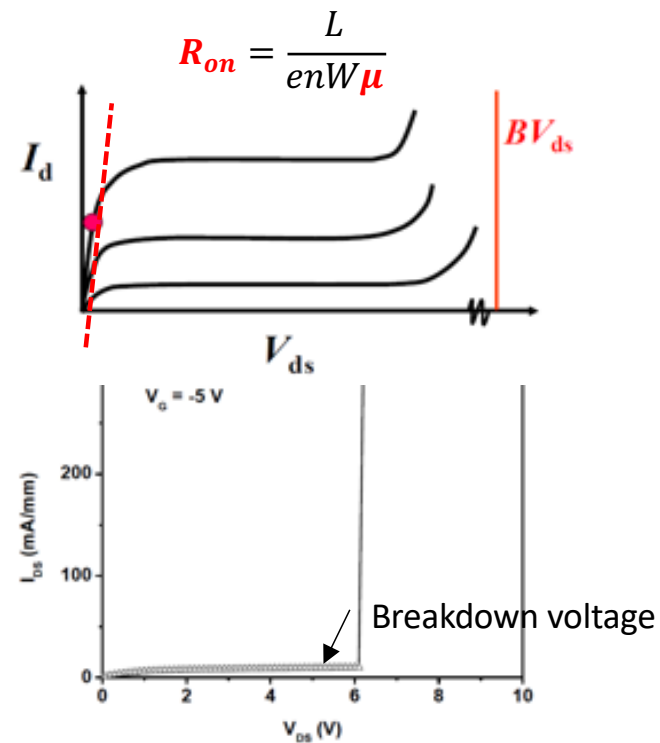
Chen, GK, GR et al, Nature communications, 2021

Epitaxial PZT films on GaN

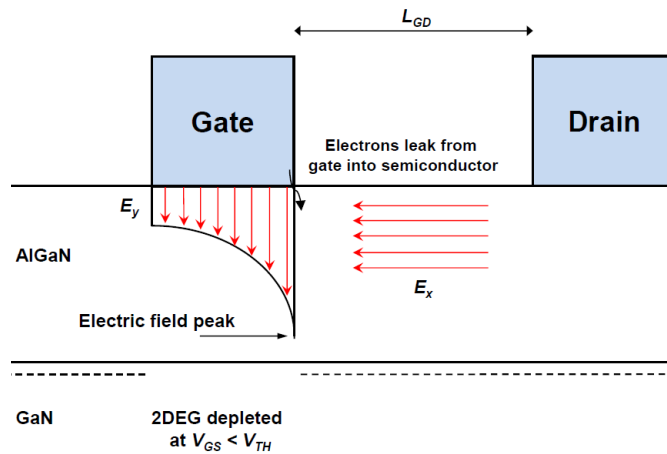
Ideal high power FET: Low R_{on} and high breakdown voltage V_{br}



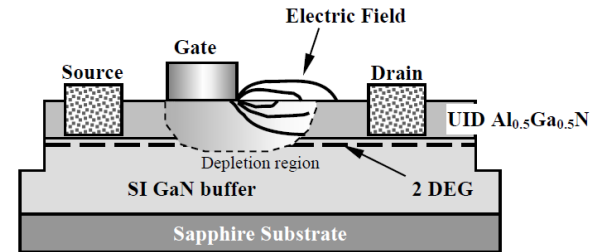
High power field effect transistor



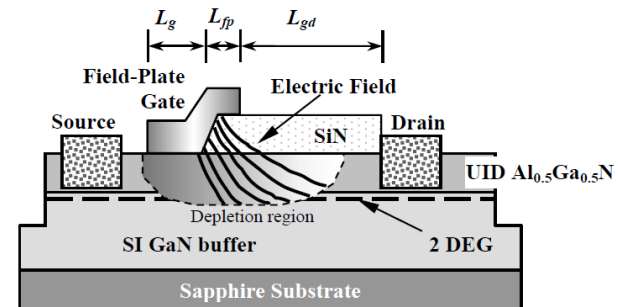
Non-uniform electric field distribution induced low breakdown voltage



Peak electric field at gate edge lower the breakdown voltage



(a) Conventional gate GaN HEMT



(b) Field-plate GaN HEMT

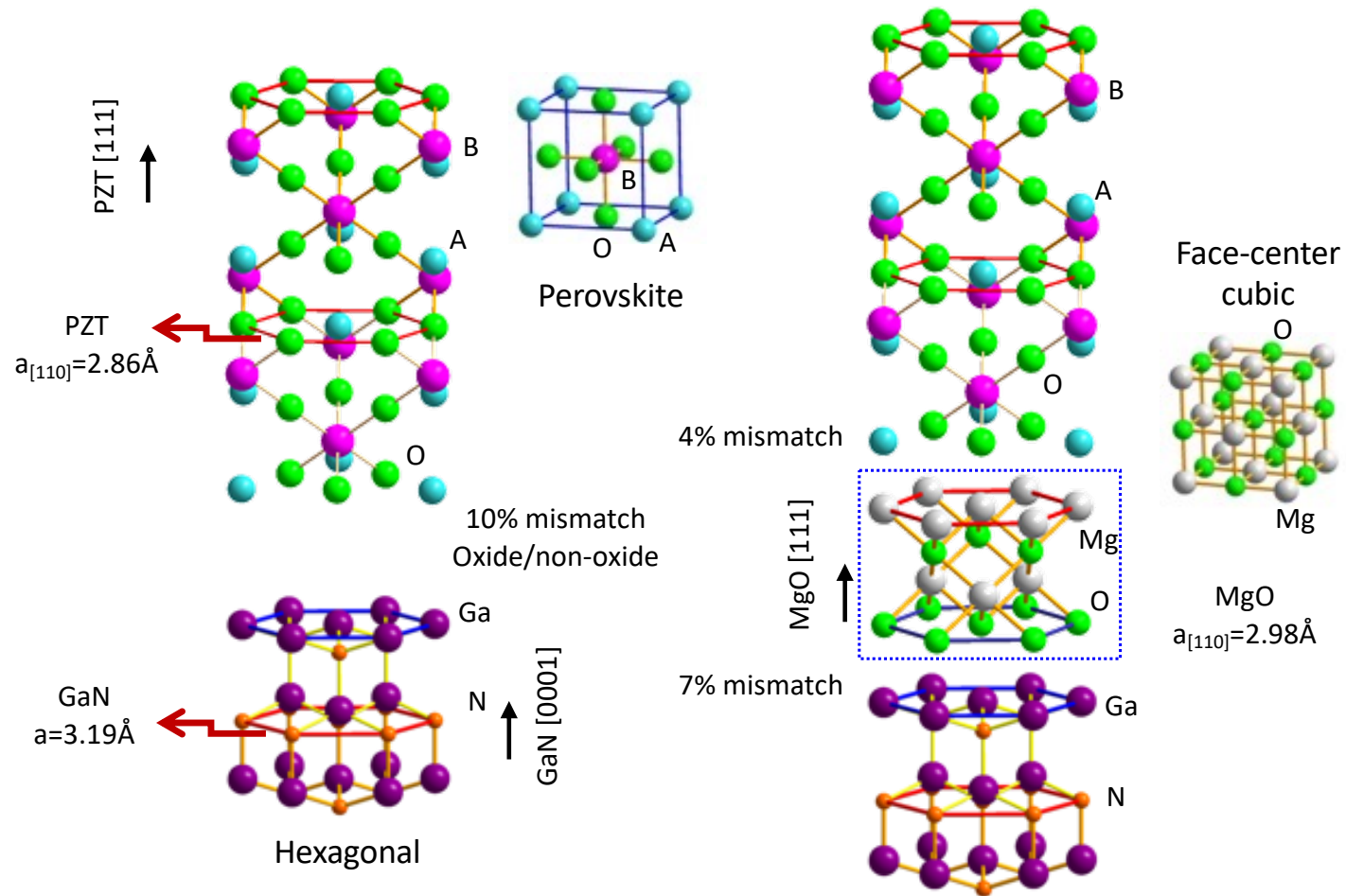
R. Zhou, GR, *et al.*, "Polarization effects in ferroelectric gate AlGa_N/Ga_N High Electron Mobility Transistors," 2020, doi: 10.1109/ISPSD46842.2020.9170173.

High Dielectric Materials

Dielectric Material	Dielectric Constant
Silicon dioxide (SiO_2)	3.9
Silicon nitride (Si_3N_4)	7-8
Aluminum Oxide (Al_2O_3)	8-10
Zirconium oxide (ZrO_2)	~14-28
Titanium oxide (TiO_2)	~30-80
Tantalum pentoxide (Ta_2O_5)	~25-50
Barium-strontium-titanate (BST/BSTO)	~100-800
Strontium-titanate-oxide (STO)	~230+
Lead-zirconium-titanate (PZT)	~400-1500

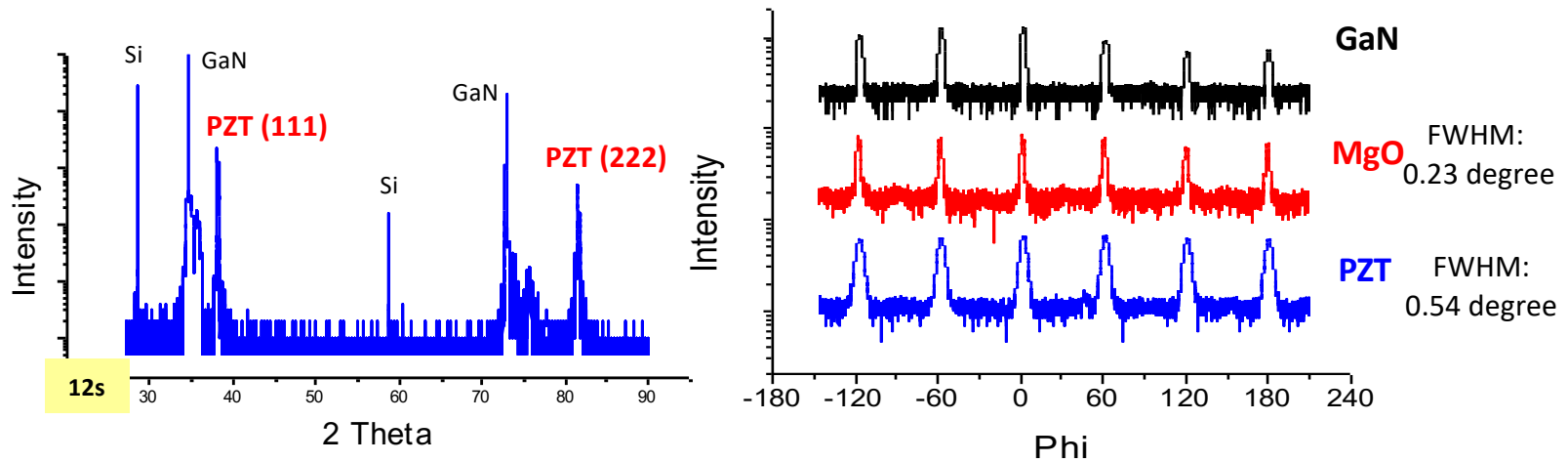
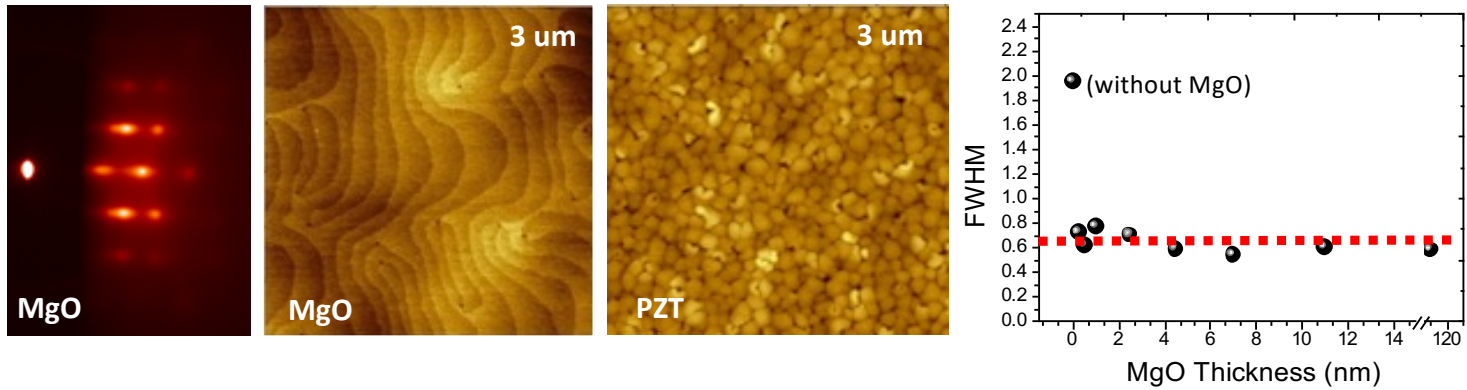
R. Zhou, GR, *et al.*, "Polarization effects in ferroelectric gate AlGaIn/GaN High Electron Mobility Transistors," 2020, doi: 10.1109/ISPSD46842.2020.9170173.

Growth of PZT on GaN

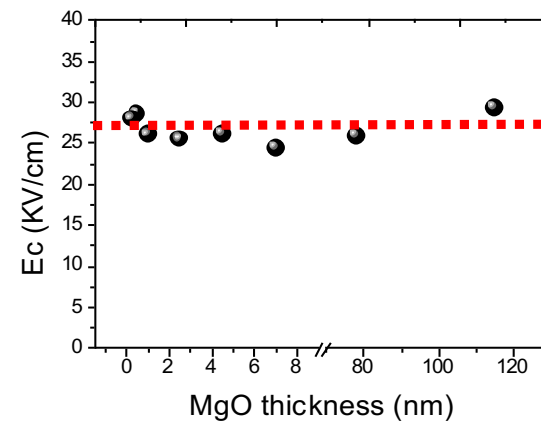
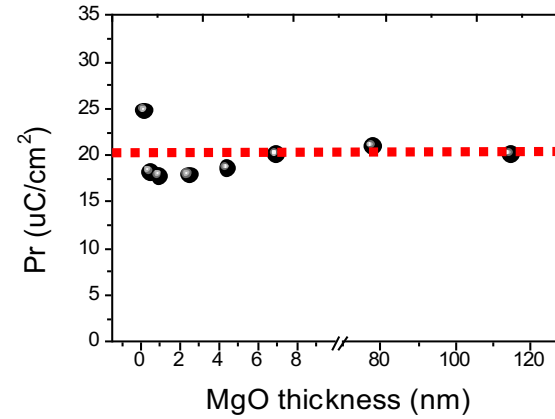
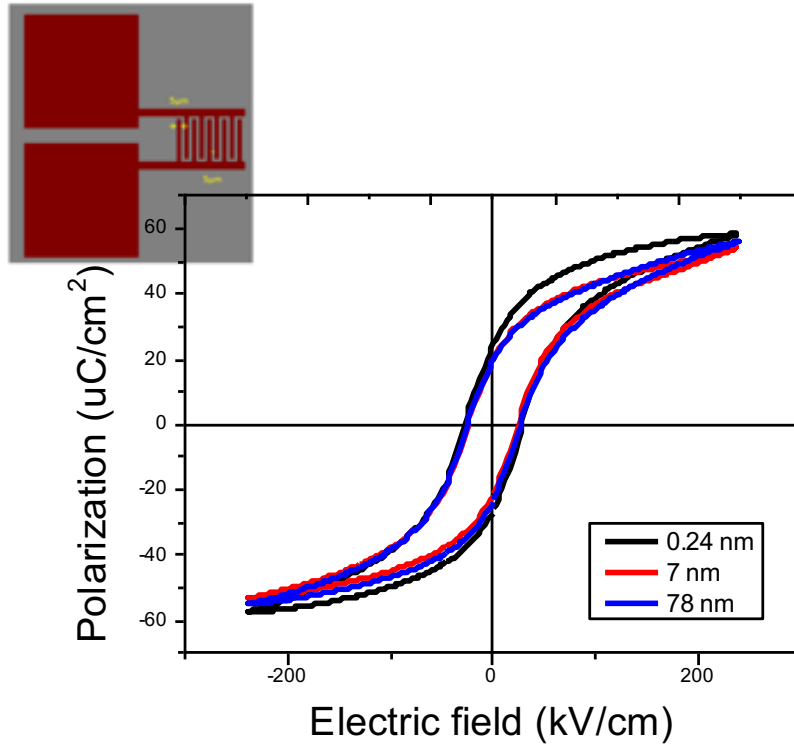


Usually, a buffer layer to reduce lattice mismatch is required to get high quality PZT.
 H. Craft, J. Ihlefeld, M. Losego, R. Collazo, Z. Sitar, J-P. Maria, "MgO epitaxy on GaN (0002) surfaces by molecular beam epitaxy." Appl. Phys. Lett. 88 212906 (2006).

Epitaxial growth of PZT on GaN

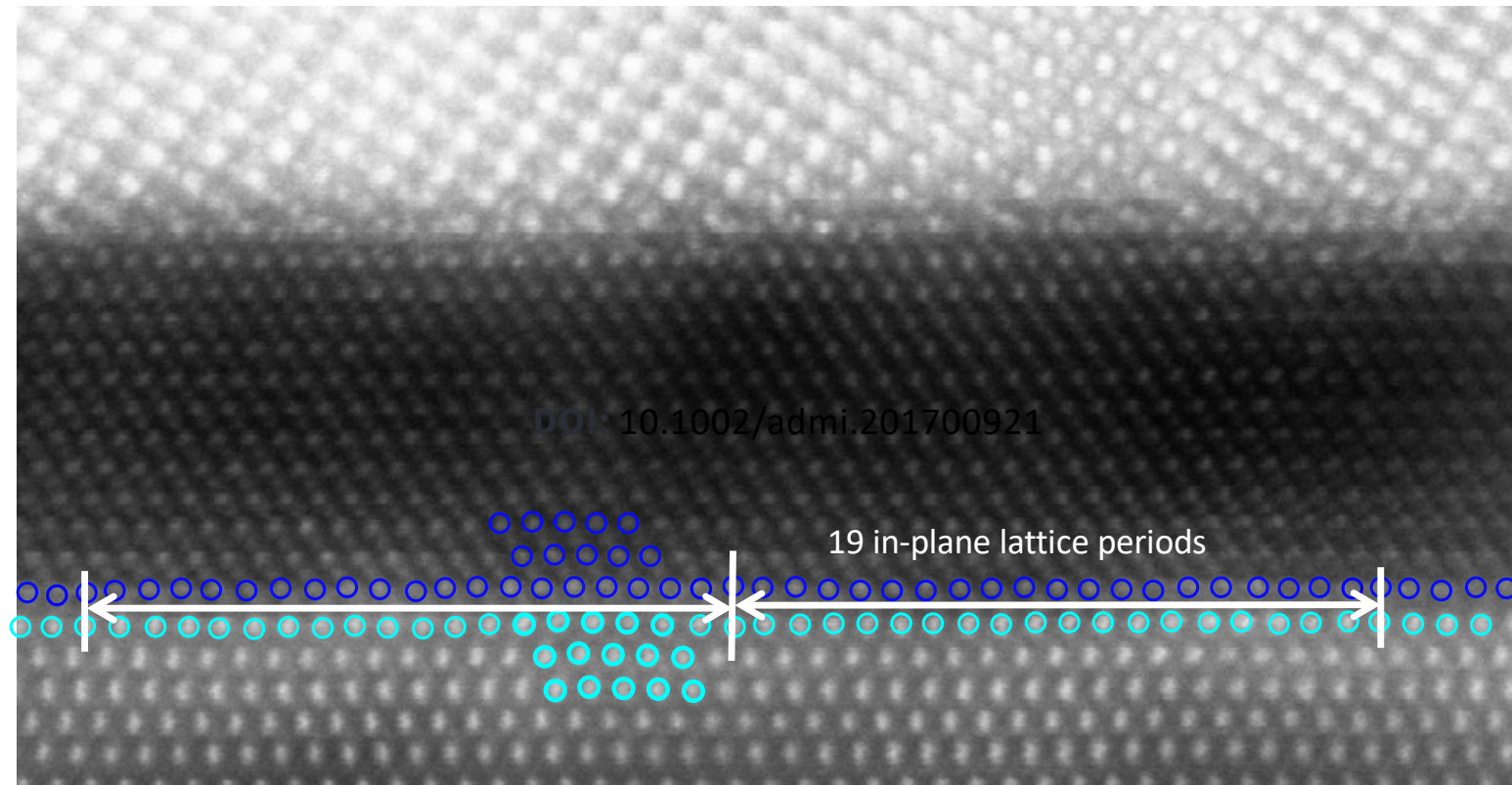


Ferroelectric property of PZT with different thickness of MgO buffer layer



Ferroelectric property of PZT can be maintained with ultrathin MgO.

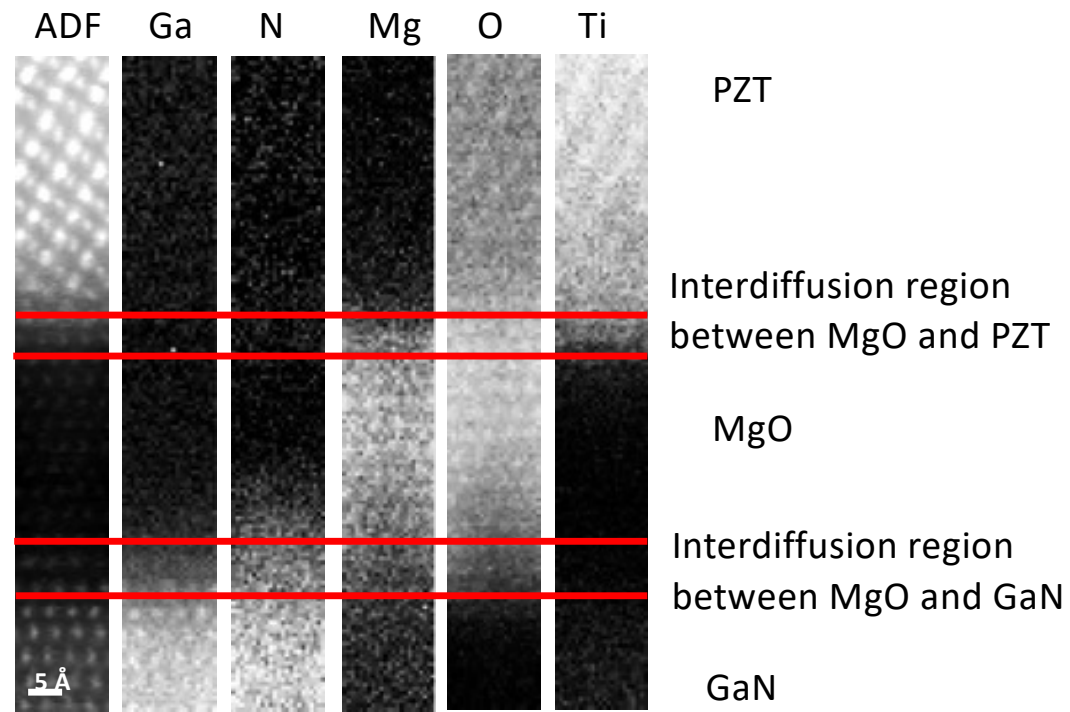
Epitaxial PZT films on GaN



Why epitaxy with lattice mismatch:
long range in-plane lattice relaxation to accommodate the strain

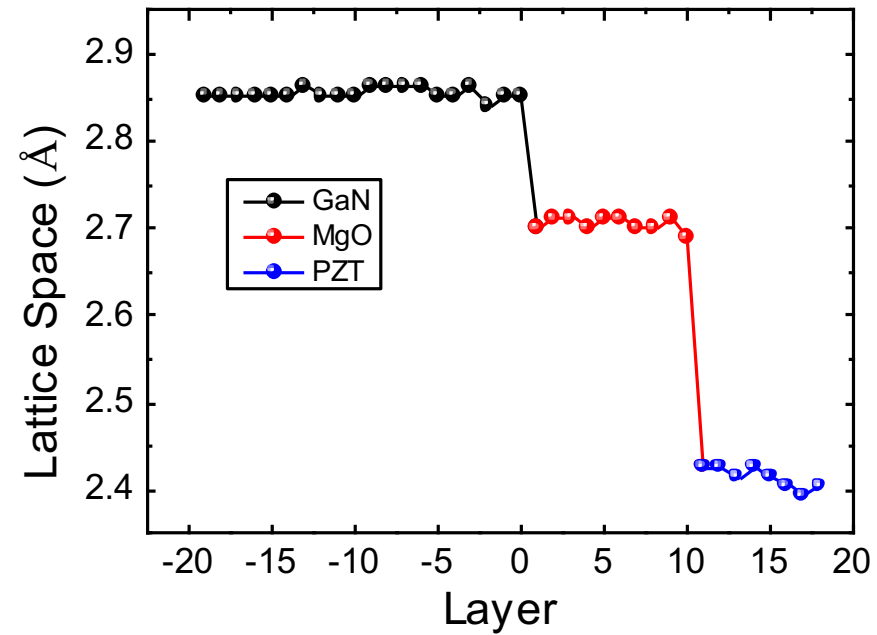
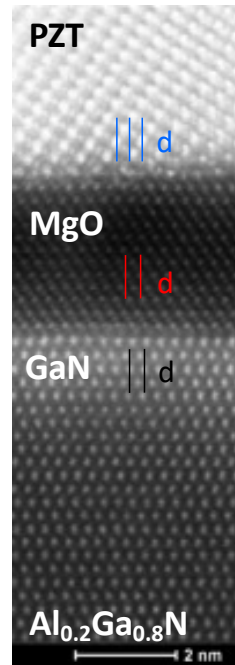
Lin Li, GR, et al. ADVANCED MATERIALS INTERFACES, DOI: 10.1002/admi.201700921

EELS mapping



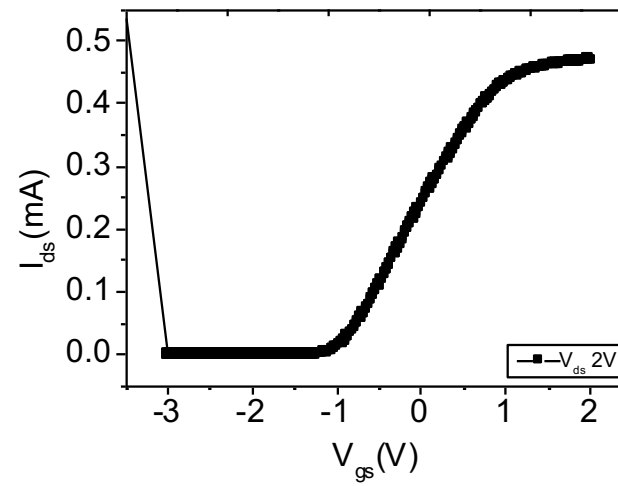
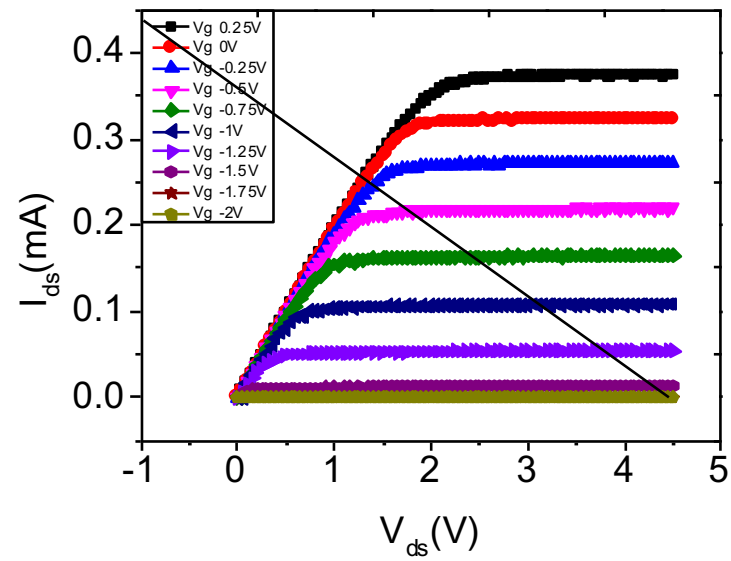
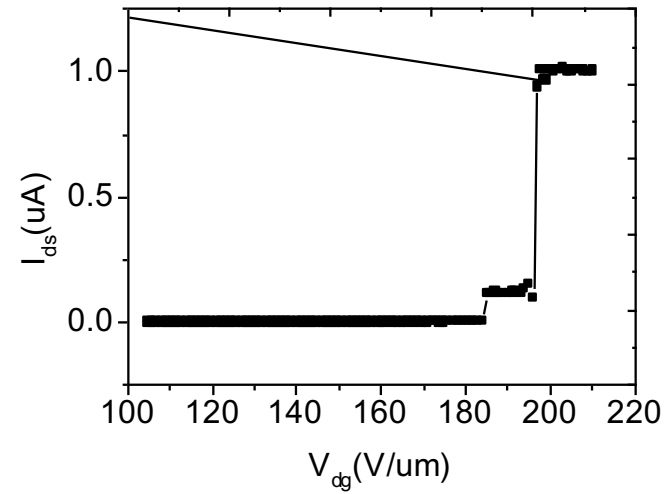
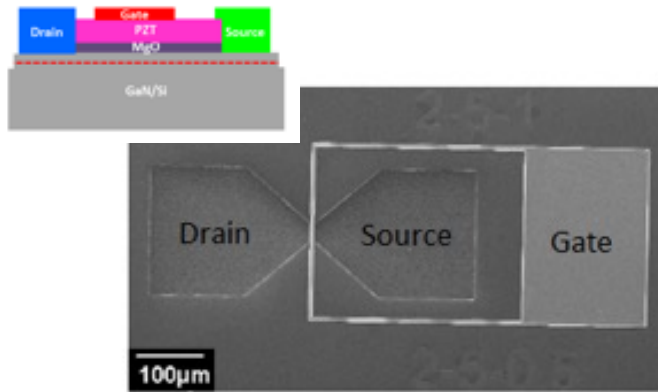
Interdiffusion region is very thin.

In-plane lattice constant profile along out-of-plane direction



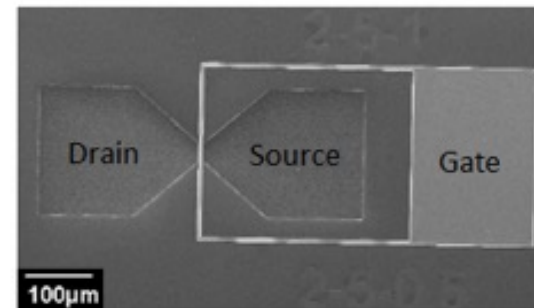
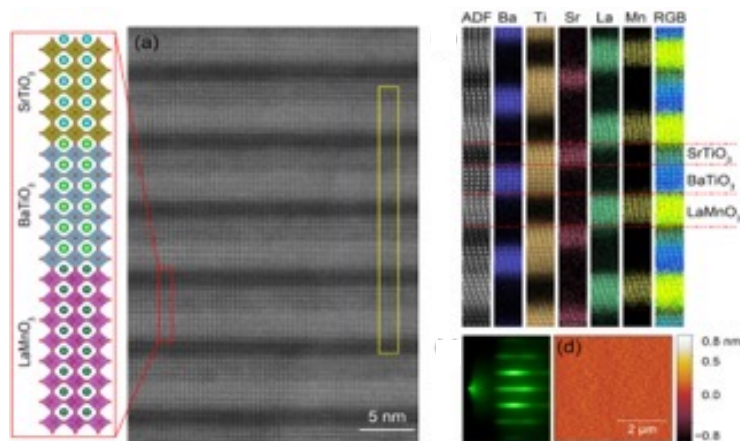
Step-transition of lattice constant without gradual relaxation can explain why thickness of MgO is not crucial to the growth of PZT.

Performance of PZT-GaN FET device



Conclusions

- High quality oxide heterostructures on buffered Si
- Oxide layers typically tensely strained
- New functionalities possible on Si and III-V, by integration of complex oxides.
- Lots of opportunities for complex oxides



A photograph of a modern building with a red facade and a glass-enclosed skybridge, set against a clear blue sky. The building's facade is composed of large, rectangular panels in a vibrant red color. A prominent feature is a glass-enclosed skybridge or walkway that connects different parts of the building, featuring a grid of glass panels. The sky is a clear, light blue, and the overall scene is brightly lit, suggesting a sunny day. The text "Thank you" is overlaid on the right side of the image.

Thank you